

Initiating coverage

Share price: SEK213.0

Technology Hardware & Equipment 08 September 2015

BUY

Target price: SEK350

Fingerprint Cards

Goldfinger

Key figures (SEK)

Salaa

We expect 71% revenue growth in 2015–17 following a commercial breakthrough in 2015. Fingerprint Cards benefits from a first-mover advantage amid a global drive for integration of fingerprint sensors into smartphones. A broad product portfolio, long experience with OEM integration, strong IP and low costs have made Fingerprint Cards a winner in this new era of biometric security mass adoption. We are initiating coverage of Fingerprint Cards with a BUY recommendation and target price of SEK350.

Given fingerprint adoption of around $\sim 26\%$ in consumer electronics currently, we calculate a total addressable consumer electronics market of USD1.67bn, growing to USD2.15bn by 2017e and 47% adoption driven by global initiatives in online banking, cloud computing and sensor technology allowing an acceptable mass-market price. Emerging verticals such as payment cards may provide additional potential.

We estimate that Fingerprint Cards has close to 100% market share in consumer electronics, excluding Apple and Samsung. With little competition initially, we estimate 71% average revenue growth and 84% EPS growth in 2015-17e. We expect the scalable business model to offset ASP and gross margin pressure, and increasing penetration to mitigate market share pressure.

The company's first-mover advantage has created an entrenched position and a large scale which is hard to compete with. We argue that the massive earnings momentum warrants at least a P/E(16e) of 15x despite technological and competitive risks tied to a new market.

Share price -5Y

2014 2015e 2016e 2017e

		Sales	234	2,476	5,701	7,248					
		EBITA	-115	578	1,591	1,977	300				
		Pre-tax profit (m)	-144	578	1,592	1,982	250 -				
		EPS	-2.41	7.31	23.85	23.77					
Jpcoming events		EPS adj.	-1.91	7.31	23.85	23.77	200 -				
Comment	Date	DPS	0.00	0.00	0.00	0.00	150 -				Į.
Q3 Report	05 Nov 2015	Sales growth Y/Y	145%	+chg	130%	27%					1
		EPS adj. growth Y/Y	-chg	+chg	226%	0%	100 -			1	
		EBITA margin	n.m.	23.3%	27.9%	27.3%	50 -		J.	Mm fr	1
Key facts		P/E adj.	neg.	29.1	8.9	9.0	o ⊨		~		
No. shares (m)	63.2	EV/EBITA	neg.	22.4	7.5	5.3	Sep 2010	Sep 2011		ep Sep 013 2014	
Market cap. (SEKm)	13,470	P/BV	6.8	15.4	5.3	3.2	2010	2011	2012 20	/13 201-	+ 2015
Market cap. (USDm) EV (2015e)	1,591 12,937	Dividend yield	0.0%	0.0%	0.0%	0.0%	_	- Fingerpi	rint Cards		
Free float	77.2%	FCF yield	-2.0%	2.8%	10.5%	10.6%		— OMX S	tockholm_Pl	(Se) (Rebas	sed)
Risk	Medium Risk	Equity/Total Assets	70.9%	57.9%	68.4%	76.8%	High/Lo	w (12M	I)	SEK272	2.5/27.9
Reuters	FINGb.ST	ROE adj.	-38.7%	83.1%	97.2%	49.7%	Perf.	3M	6M	12M	YTD
Bloomberg	FINGB SS	Net IB debt/Equity	-33.8%	-65.8%	-83.3%	-86.9%	Abs.	68.0	447.6	323.9	512.1
Home page	www.fingerprints.com	Net IB debt/EBITDA	1.2	-0.9	-1.2	-1.7	Rel.	81.5	503.8	290.I	495.9
	Source: Carnegie Research	Price SEK213.0					9	Source: C	arnegie F	Research,	Factset

Please see disclosures on page 44

Carnegie Research

Research analysts: Håvard Nilsson +47 22 00 93 78 hn@carnegie.no

Sweden

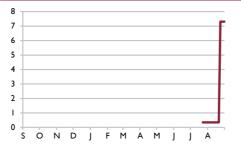


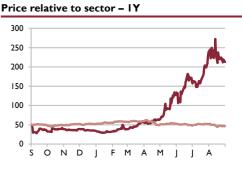
Performance & valuation











— Fingerprint Cards

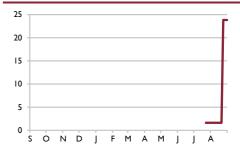
- Carnegie

Source: Factset

Technology Hardware & Equipment

Source: Factset

Adj. EPS expectations - 2016e



— Carnegie — Consensus

— Consensus					-	— Con	sensus	
Sou	ırce: Fact	tset, Ca	rnegie R	lesearch	'n			S
Performance						Valuatio	on	
snapshot	IM	3M	12M	YTD		snapsho	ot	
Fingerprint Cards %	-10.5	68.0	323.9	512.1		P/E		
						P/E adj.		
Peer group %	-13.3	17.1	93.3	94.4				
Carnegie Tech Hard & Equip %	-10.0	-12.7	-5.8	-10.9		EV/EBITE		
OMXSPI %	-8.2	-7.4	8.7	2.7		EV/EBITA	Ą	
MSCI Nordic %	-8.6	-8.2	7.1	6.0		P/BV		
						P/BV ex.	GW	
MSCI Europe %	-10.4	-9.1	-3.3	-1.1		., 5. 6.	011	
S&P 500 %	-7.5	-8.2	-4.3	-6.7		Dividend	yield	
MSCI World %	-8.9	-9.2	-3.5	-4.6	_	FCF yield		
			Source:	Factse	t			
					P/E	Adj.	P/E A	٨dj.
Peer group					Carr	iegie	Conse	nsus
comparison	Ra	t. Cur	r. P	rice	15e	16e	15e	16e
Fingerprint Cards	Βι	ıy SE	K 21	3.00	29.I	8.9	n.a.	n.a.
Next Biometrics	Βι	iy NC	ОК 4	3.70	n.m.	18.0	n.a.	n.a.
Nordic Semiconductor	Βι	iy NC	ОК 4	4.14	34.3	19.0	31.2	17.5
Weighted avg.					34.7	11.1		

Source: Factset, Carnegie Research

						•					
	Valuatio	on									
	snapsho	t		2014	2015e	2016e	2017e				
	P/E			n.m.	29.1	8.9	9.0				
	P/E adj.			n.m.	29.1	8.9	9.0				
	EV/EBITC	DA		neg.	21.2	7.1	5.0				
	EV/EBITA	\		neg.	22.4	7.2	5.1				
	P/BV		41.33	15.38	5.32	3.20					
	P/BV ex.	GW		41.33	15.38	5.32	3.20				
	Dividend	vield		0.0%	0.0%	0.0%	0.0%				
	FCF yield			-2.0%	2.8%	10.5%	10.6%				
1											
/E	Adj.	P/E A	dj.	EV/EBI	TA E	BITA	Div.				
arı	negie	Conse	nsus	Carneg	gie №	1argin	Yield				
ie	16e	l5e	16e	l5e	16e	16e	15e				
.1	8.9	n.a.	n.a.	22.4	7.2	27.9%	0.0%				

neg. 25.4

26.2

Source: Carnegie Research

12.0 13.9%

13.3 20.3%

8.8 25.1%

0.0%

0.0%

0.0%



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Investment case

	Fingerprint Cards (FPC) is looking to grow revenue by 960% in 2015e, enjoying its first- mover advantage in a global drive for integration of fingerprint sensors into smartphones. A broad product portfolio, long experience with OEM integration, strong IP and low costs have made Fingerprint Cards a winner as we enter an era of biometric security mass adoption. With around ~25% fingerprint adoption currently, we calculate a total addressable consumer electronics market of USD1.67bn, growing to USD2.15bn by 2017e driven by global initiatives in online banking, cloud computing and sensor technology allowing an acceptable mass-market price. We estimate Fingerprint Cards has close to 100% market share in consumer electronics, excluding Apple and Samsung. With little competition initially, we estimate 71% average revenue growth and 84% EPS growth in 2017e. We believe Fingerprint Cards has ample potential and we initiate coverage with a BUY recommendation and a target price of SEK350, reflecting a P/E(16e) of 15x.
Close to 100% market share in consumer electronics excluding Samsung & Apple	FPC was the first and currently one of three companies delivering fingerprint sensors to the largest smartphone/tablet producers in the world. Its market share excluding Apple and Samsung is close to 100% in consumer electronics. Apple uses proprietary technology and Samsung uses Synaptics and Egistec. With a surge of smartphones entering the global market in 2015, most OEMs have picked FPC as provider of fingerprint scanner components, i.e. Huawei, Sony and HTC, together with smaller Asian brands such as Coolpad, ZTE and Meizu. Consequently revenue guidance in 2015 is for SEK2.5bn, up from SEK234m in 2014, or 960% growth Y/Y driven by a stunning SEK1.25bn order inflow in Q2(15).
Secular trends are enforcing higher security and rendering PIN codes obsolete	Trends in the global payment industry, moving towards online banking and digital points of sale, together with cloud computing and 'the internet of things' central for adoption of fingerprint sensors across consumer and industrial applications. These trends enforce demand for greater security through convenient solutions. Biometric security is the cornerstone of ID verification and is the only viable technology to date that is sufficiently low cost.
USD2.15bn market in 2017e based on 47% adoption	We calculate a current total addressable consumer electronics market for FPC of USD1.67bn in 2015e, based on a 25% penetration rate. As we have witnessed massive adoption of fingerprint scanners in most high-end phones and low-cost smartphone OEMs in Asia due to mobile payment support, we see penetration of 37% in 2016e. We calculate an addressable consumer electronics market in 2017e of USD2.15bn based on 47% adoption. Additional opportunities may reveal themselves in traditional verticals such as time & attendance application and payment cards. Successfully driving adoption of payment cards may open a USD1.4bn–2.2bn market in few years.
Entrenched position due to a first mover advantage	We believe FPC has ample potential. The combination of several strategic moves has made the company the preferred sensor supplier for the most important market, smartphones and tablets. A success attributed to proven manufacturing process, broad product portfolio and integration precision on the back of long experience. FPC can deliver a high-quality sensor, at low cost, and strong performance comparing to peers.
71% average revenue growth 2015-17e	We estimate a revenue CAGR(15-17e) of 71% with an average EBIT margin of 27% in our forecast period. Here, we have accounted for significantly increasing competition from new vendors entering the market. We expect ASP and, consequently, gross margin pressure to be offset by a scalable business model. We expect falling market share to be offset by increasing performing. We adjust fully diluted EDS(15c) of SEK7.0, proving to EDS(17c) of SEK23
Target of SEK350 based on 15x EPS(16e) of SEK24	penetration. We calculate fully diluted EPS(15e) of SEK7.0, growing to EPS(17e) of SEK23. Despite technological and competitive risks, we argue the massive earnings momentum warrants a PE(16e) of 15x. We initiate coverage of FPC with a BUY and target of SEK350.



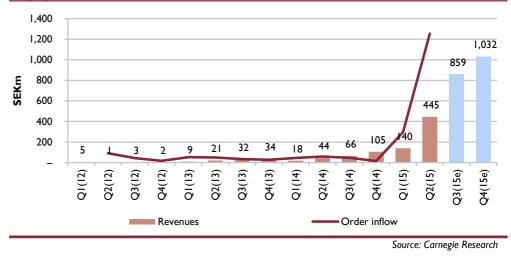
We see four main risks to our investment case:

- Competitive pressure may result in severe ASP and gross margin fall.
- Fingerprint sensor penetration may develop slower than expected.
- Competing ultrasonic technology reaches mass market acceptable prices.
- Change in smartphone/tablet design trends. Current initiatives are pointing to sensor integration under the cover glass and we have yet to see a product from FPC.

Estimates

Prominent clients such as Huawei, HTC and Sony FPC is facing a fast-growing market for integrated fingerprint sensors smartphones and tablets. The order backlog ended Q2(15) on SEK1.34bn after SEK1.25bn order inflow. The volumes were mainly driven by formidable smartphone vendors such as Huawei, Sony and HTC. Other Asian manufacturers contributed as well. Namely: Oppo, Newman, LeTV, Coolpad, Gionee, Meizu, Dazen, ZTE, Oneplus and ZUK.

Fingerprint Cards: Revenues & order inflow



As the company was able to increase its production capacity earlier than expected management lifted revenue guidance to SEK2,500m for 2015e. The company is guiding for approx.. SEK860m in Q3(15e). We estimate revenue of SEK2,476m for 2015e reaching SEK8.25bn in 2017e.

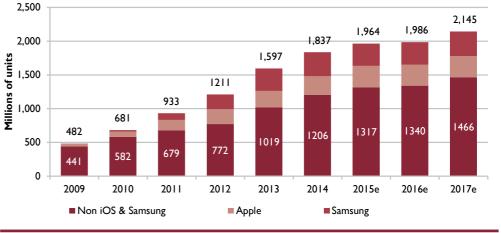
Revenue and gross margin

We expect revenue to grow by 130% in 2016e and 27% in 2017e driven by increasing adoption of fingerprint sensors in consumer electronics. We have built a top-down forecast model for FPC, largely based on forecast growth in smartphones, tablets and notebooks and penetration rates. We expect 31% smartphone penetration in 2015e, reaching 45% in 2016e. Tablet penetration is around 25% in 2015e. We expect to see sensors being integrated into notebooks from 2016e and significant volumes from 2017e. In sum, we estimate total non-Apple penetration to grow from 25% in 2015e to 37% in 2016e and 47% in 2017e.

We have delimited the addressable market to smartphone, tablet and notebook vendors excluding Samsung and Apple. Apple has been using a proprietary solution since buying Authentec, while Samsung uses Synaptics (Validity). We base our global volume estimates on forecasts by formidable industry experts: IDC and Gartner. For 2015–17e we have assumed a 20% market share for Samsung.

We expect the main revenue driver to be increasing adoption of sensors in consumer electronics

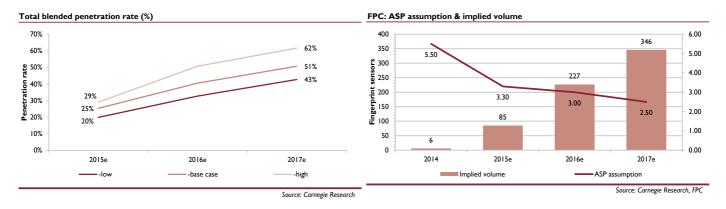




FPC: Adressable Smartphone, Tablet & Notebook volumes

Opportunity within payment cards

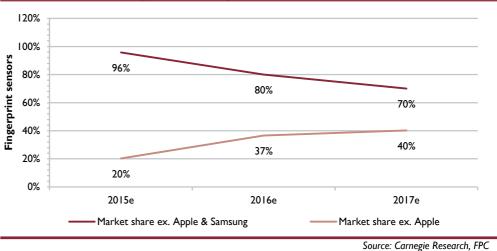
There are opportunities in payment card integration that we expect to materialise in 2016 with volumes from 2017 and beyond, not included in our estimates. In addition, FPC is shipping a number of sensors used in the Chinese banking sector. Roughly 10% of H1(15) revenues were non-smartphone related, of which the majority for the Chinese banking sector. 10% of H1(15) revenues is ~SEK58m, or SEK116m annualized, and is considered 'run-rate'.



We account for increasing competition pressuring ASP, gross margin and market share Due to rapidly changing market dynamics we take a rather conservative stance. We base our revenue forecasts on a market share estimate and ASP assumption. With new market entrants we expect market shares to decline from ~96% in 2015e to 80% in 2016e and 70% in 2017e. With competitive pressure we also assume ASP falling from ~USD3.3 to USD3.0 in 2016e and USD2.5 in 2017e. The most formidable competitors is Goodix, Egistec and potentially Silead.

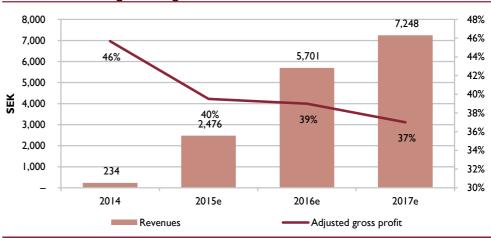
Source: Carnegie Research





FPC: Market share ex. Apple & Samsung

With increasing competitive pressure we remain wary of FPC's ability to maintain gross margins. FPC's gross margin inherently scales upwards with falling sensor size as cost falls more than price currently. Hence the management expects the gross margin adjusted for depreciation of R&D expenses and shipment cost will be in the mid-40s. However, we take a cautious stance and expect competitive pricing pressure to offset margin gains. Unfortunately there are no peers against which to benchmark gross margins.



FPC: Revenues and gross margin

Cautious view on gross margins



Company	Country	Technology	Mass production
Fingerprint Cards	Sweden	Capacitive	Yes
Goodix	China	Capacitive	Yes
Synaptics (Validity)	USA	Capacitive	Yes
Egistec	Taiwan	Capacitive	Yes
Next Biometrics	Norway	Active Thermal	Yes
Silead	China	Capacitive	No
IDEX	Norway	Capacitive	No
Qualcomm	USA	Ultrasonic	No
Vkansee	China	Optical	No
BYD	China	Capacitive	No
FocalTech	Canada	Capacitive	No
Microarray	China	Capacitive	No

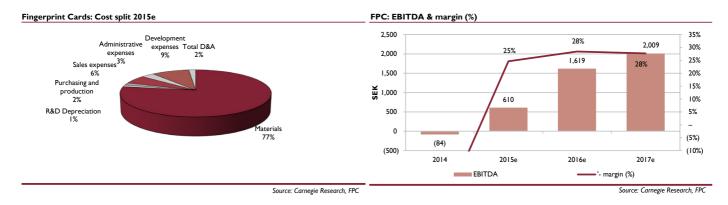
Competitive landscape

Source: Carnegie Researd

Costs

The main cost is silicon for producing sensors. For 2015e, we expect 77% of cost to be materials. To enable the huge growth ahead, we pencil in significant ramping of sales expenses, increasing administrative expenses and R&D to meet future demand for different sensor applications and continuous improvement of existing technology.

FPC is a fast growing organisation which makes it hard to estimate how fast cost will scale. As our base case we estimate a 10% sequential Q/Q opex (excl. COGS) growth through 2015 and 2016e. For 2017e we pencil in 20% Y/Y growth in opex (excl. COGS).



Share count and EPS

Significantly dilutive warrants programme

FPC has a significant number of warrants outstanding as a part of employee compensation programmes. Some 11.33% of the share capital will be diluted over the next couple of years with 8.25% for exercise on 6 September–6 October 2015. Our EPS calculation assumes all warrants fully diluted. As the warrants are deep in the money we have assumed full dilution of shares and included SEK160m in our cash flow estimate. The current share count is 58.4m and 65.0m fully diluted.

Dilutive instruments	# shares	Dilution	Strike	Min. cash	Exerc	isable
Туре	Millions	(%)	SEK	SEK	From	То
Warrants - "TO4"	4.82	8.25%	9.7	46.8	06-Sep-15	06-Oct-15
Warrants - "TO5"	1.30	2.23%	52.4	68. I	05-Feb-16	05-Mar-16
Warrants - "TO6"	0.50	0.86%	90.2	45.1	27-Nov-16	27-Dec-16
Total	6.62	11.33%	24.2	160.0		

Source: Carnegie Research, Fingerprint Cards



We calculate a fully diluted EPS(15e) of SEK7.0 growing 232% to EPS(16e) of SEK29.0. We expect EPS(17e) of SEK27.3. The decline in EPS from 2016–17 is explained by FPC fully utlising its deferred tax assets in 2016e. FPC had SEK415m in deferred tax assets at YE(14).





Note: Assumes full dilution of outstanding warrants: 11.33% of share capital

Source: Carnegie Research

Fingerprint Cards AB	2014				2015								
SEKm	QI	Q2	Q3	Q4	QI	Q2	Q3e	Q4e	2013	2014	2015e	2016e	2017e
Total revenue	18	44	66	105	I 40	445	859	1,032	95	234	2,476	5,701	7,248
Adjusted gross profit	9	21	30	46	51	171	335	422	54	107	978	2,223	2,682
-margin (%)	49%	47%	46%	44%	36%	38%	39%	41%	56%	46%	40%	39%	37%
COGS	-15	-31	-45	-71	-103	-286	-537	-627	-56	-162	-1,553	-3,562	-4,670
Gross profit	4	13	21	34	37	159	322	405	39	72	924	2,138	2,578
-margin (%)	20%	30%	32%	32%	27%	36%	38%	39%	41%	31%	37%	38%	36%
Total Opex	-30	-58	-65	-64	-56	-94	-93	-103	-73	-217	-346	-547	-602
EBITDA	-22	-24	-21	-17	-7	75	239	302	-21	-84	610	1,619	2,009
- margin (%)	neg.	neg.	neg.	neg.	neg.	17%	28%	2 9 %	neg.	neg.	25%	28%	28%
Total D&A	-4	-21	-23	-14	-12	-10	-10	0	-13	-62	-32	-29	-33
EBIT	-27	-45	-44	-30	-19	66	229	302	-34	-145	578	1,591	1,977
Interest income / (expense)	I	0	I	I	0	0	0	0	I	2	0	I	5
РТР	-26	-45	-44	-29	-19	66	229	302	-33	-144	578	1,592	1,982
Tax	0	0	0	-1	0	0	-50	-66	0	0	-117	-62	-436
Net Income	-26	-45	-44	-30	-19	66	179	236	-33	-145	46 I	1,530	1,546
Undiluted EPS	-0.5	-0.8	-0.8	-0.5	-0.3	1.1	3.1	4.0	-0.6	-2.5	7.9	26.2	26.5
Diluted EPS	-0.4	-0.7	-0.7	-0.5	-0.3	1.0	2.8	3.7	-0.6	-2.3	7.3	23.5	23.8
KPI's													
Cash flow from operating activities	-23	-36	-41	-75	21	50	132	196	-29	-174	398	1445	1463
Capital expenditures	14	33	5	39	2	4	4	4	38	91	15	29	36
Order inflow (YTD 2015)	45	60	47	16	295	1254			165	168	1549		
Backlog (SEKm)	41	63	50	71	364	1335			23	71			



Valuation

Valuating high-growth technology stocks is a difficult task due to a high degree of uncertainty and cash flow well into the future together with limited historical figures. The fingerprint sensor sub-sector is completely new and we have yet to see how its ecosystem will ultimately develop. To evaluate FPC we have evaluated three approaches: theoretical, DCF and peer comparison.

- A theoretical approach suggests a fair P/E(16) of 28x.
- A DCF suggests a more moderate view and reflects a fair P/E(16e) of 15x.
- A peer-based approach suggests a fair multiple of 13–40x.

We conclude a target of SEK350, reflecting a P/E(16e) of 15x. Our target reflects a 15% premium to the Nordic Technology Hardware sector, trading at 13x P/E(16e). We believe a premium to the sector is warranted due to the high relative growth prospects. We believe the considerable uncertainty linked to how this new sub-sector will evolve will limit upside in the short term. If FPC can maintain its strong market share in the medium term there is a clear valuation upside as reflected by peer multiples ranging from 20–45x P/E.

Theoretical approach

For the theoretical approach we use a Gordon's growth model. Our assumptions are outlined below. The model is driven by earnings growth. We have assumed a 29% average growth rate over a 5-year period 2015–20. With minimal investment the reinvestment ratio is 90%, which yields a 'fair' earnings multiple of 28x.

	Th	eor	etica	P/E	ratio
--	----	-----	-------	-----	-------

EPS 2016e	23.85
Number of years in period I	5
Growth rate period I	29.0%
Pay-out ratio period I	90%
Growth rate after period I	1.0%
Pay-out ratio after period I	90%
Risk free rate	3.50 %
Risk premium	5.75 %
Beta	1.21
Required rate of return	10.46%
Motivated P/E ratio	28.2
Actual P/E ratio	9.2
Repricing potential	207%
	Source: Carnegie Research



DCF approach

Our DCF assumptions are listed below, where we arrive at a fair value of SEK363.

Valuation	Per share	WACC calculation		2015-2020 average assumpt	ions
EV	337	Risk-free rate	3.5%	Revenue growth	31.5%
Net debt	2	Debt risk premium	0.5%	EBITDA margin	25.4%
Equity value at YE(14)	339	Equity risk premium	5.8%	EBIT margin	22.5%
Time adjustment	24	Equity beta	1.21		
Current equity value	363	Cost of equity	10.5%	Terminal period	
		Tax rate	22%	Revenue growth	3.0%
Implicit PE(15e)	50x	Weight of equity	100%	EBITDA margin	20.0%
Implicit PE(16e)	5x	WACC	10.5%	Terminal % of total EV	47%

Source: Carnegie Research

Peer comparison

There are few direct peers for FPC. However, we compare it to Nordic technology hardware peers and international high-growth technology companies. With superior growth of an estimated 71% in 2015–17e we argue it should be valued among the top percentile of peers. Multiples range from 20–47x and above for 2016 earnings for companies growing above 20%.

Another fingerprint sensor designer in the Nordics is Next Biometrics. However, the company has had little traction with OEMs as yet and therefore estimates are highly uncertain. Thus, the most comparable company in the Nordics is Nordic Semiconductor (NOD). NOD's main growth driver is Bluetooth SMART chipsets, the standard communication standard for devices related to the internet of things. Thus its partly mono product exposure and structural growth drivers are highly comparable. NOD trades at 19x 2016 earnings and has traded at 23x on average for the past four years.

It is also relevant to compare to other international high-growth technology companies. Our selection below is technology hardware companies listed in Europe or the US. The median P/E(16e) for companies growing more than 20% in 2015–17e is 22.5x. The median for semiconductor companies only is 20.0x. The top 75th percentile trades at 46x and above, with median growth of 32%.

As we expect FPC to grow 71% in 2015–17e we argue that the top percentile multiples are warranted. However, Fingerprint Cards is a mono-product company which carries considerable technological risk. Until we see how the how the competitive landscape evolves we find it unlikely that investors will pay a significant premium to the Nordic sector trading at 13x P/E(16e).

Companies	Market cap	Revenue CAGR		P/E		EV	EBITE	A	EV/Sales		Gross margin		
USDm	Current	2015-17e	2015e	2016e	2017e	2015e	2016e	2017e	2015e	2016e	2017e	2015e	2016e
Fingerprint Cards	1,582	71%	29.0x	8.9x	8.9x	21.1x	7.lx	5.0x	5.2x	2.0x	I.4x	37%	38%
Fingerprint Cards vs. Nordic sector				-31%	-28%	178%	11%	-15%	388%	98%	45%		
Fingerprint Cards vs. Tier I high	growth peers m	edian	-10%	-60%	-49%	12%	-47%	-53%	43%	-33%	-39%		
Nordic Peers													
Synaptics	2,589	33%	2. x	10.0x	9.0x	9.0x	6.7x	5.5x	I.4x	I.0x	0.8x	34%	38%
Next Biometrics (CARe)	57	192%	-7.8x	17.3x	6.1x	neg.	11.0x	3.8x	8.0×	I.6x	0.9x	35%	46%
Nordic Semiconductor (CARe)	876	25%	34.3x	19.0x	17.3x	20.7x	11.8x	10.4x	3.9x	2.7x	2.3x	50%	47%
Nordic Sector (technology ha	ardware)	2%	16.2x	l 2.8x	l 2.5x	7.6x	6.4x	5.9x	l.lx	I.0x	1.0x	46 %	48%

Source: Carnegie Research, Factset 07/09/2015



International high growth technology (Tier I - >20% growth)

incernational mgn growen ceem		- 10 /0 gi o i c	.,										
Figeac Aero	610	29%	25.7x	15.0x	9.3x	n.a.	n.a.	n.a.	2.7x	1.9x	I.4x	n.a.	n.a.
Nimble Storage	1,917	38%	n.a.	130.2x	40.4x	n.a.	103.3x	33.6x	5.0×	3.5x	2.5x	68%	67%
SolarEdge	2,473	62%	55.5x	19.8x	13.7x	28.9x	12.5x	7.8x	2.8x	1.8x	I.4x	25%	29%
Nordic Semiconductor (Carnegie)	876	25%	34.3x	19.0x	17.3x	20.7x	.8x	10.4x	3.9x	2.7x	2.3x	51%	49 %
Palo Alto Networks	13,576	38%	194.6x	99.5x	66.2x	90.1x	42.6x	28.5×	14.3x	10.2x	7.5x	77%	78%
Universal Display	1,693	21%	33.6x	22.5×	12.6x	13.9x	11.3x	7.8x	6.5×	4.8x	3.4x	74%	84%
AIXTRON	723	16%	n.a.	96.2x	25.8×	n.a.	15.4x	9.2x	1.9x	I.4x	I.2x	24%	33%
Harris	9,147	16%	14.4x	12.9x	12.0x	15.7x	8.4x	7.4x	2.7x	I.7x	I.6x	34%	33%
M/A-COM	1,547	21%	18.4x	15.5x	11.8x	.6x	10.2x	8.8x	3.3x	3.1x	2.1x	52%	58%
Arista	4,760	28%	34.8×	30.1x	26.4x	19.6x	15.8x	12.3x	5.5×	4.2x	3.2x	65%	64%
Inphi	891	33%	23.8×	19.0x	14.4x	13.5×	10.6x	5.5×	3.3×	2.6x	1.7x	67%	67%
Cavium	3,801	19%	43.1×	32.6x	25.3×	28.1×	20.4x	15.2x	8.7x	7.0x	5.5x	66%	66%
u-blox	1,325	20%	32.4x	26.4x	21.6x	16.5x	13.4x	II.Ix	3.6x	3.0x	2.5x	45%	45%
Fortinet	7,116	24%	80.5×	59.2x	43.9x	36.5x	26.4x	20.3x	6.1x	4.7x	3.7x	71%	71%
Telit	609	20%	24.4x	16.4x	13.0x	13.7x	9.4x	7.1x	1.8x	I.4x	l.lx	40%	41%
Ambarella	2,295	30%	23.4x	20.3x	17.4x	18.3×	13.6x	II.4x	6.1x	4.7x	3.6x	64%	63%
Infinera	2,808	21%	30.1x	22.6x	18.7x	19.5x	13.5x	10.7x	3.1x	2.6x	1.9x	48%	51%
25th percentile		20%	23.8x	17.7x	12.8x	13.8x	10.8x	7.8x	2.8x	1.9x	1.5x	41%	42%
Median		24%	32.4x	22.5x	17.4x	18.9x	13.5x	10.6x	3.6x	3.0x	2.3x	58%	60%
- of which median Semiconductors		26%	28.1x	20.0x	15.9x	17.4x	13.0x	10.0x	3.5×	3.0x	2.3x	58%	60%
75th percentile		32%	43.lx	45.9x	26.1x	28.3x	19.2x	14.5x	6.1x	4.7x	3.5x	67%	67%

International high growth techn	nology (Tier	2 - <20% growt	h)						Source. e	annegre i	teseuren,	Factset U/	10772013
TASER	1,273	19%	53.3x	45.4x	30.7x	24.3x	20.2x	n.a.	6.1x	5.0x	n.a.	66%	65%
Ruckus Wireless	982	17%	26.7x	20.3x	16.0x	15.4x	10.5x	6.3x	2.2x	1.8x	I.3x	69%	69%
3D Systems	1,424	15%	39.6x	19.8x	14.7x	9.3x	6.2x	5.0x	1.8x	1.5x	I.2x	49%	50%
Monolithic	1,910	17%	26.1x	21.6x	20.2x	23.6x	18.2x	n.a.	5.4x	4.6x	n.a.	55%	56%
NXP Semi	19,615	14%	14.3x	12.8x	10.6x	11.3x	9.9x	8.8x	3.5×	3.1x	2.3x	49%	49%
Stratasys	1,467	10%	54.2x	27.5x	17.3x	8.8x	6.8x	6.7x	1.8x	1.6x	I.3x	54%	55%
Super Micro	1,145	22%	11.3x	10.0x	8.7x	6.7x	5.4x	4.6x	0.6x	0.5x	0.4x	16%	16%
IPG Photonics	4,269	16%	17.5x	15.5x	12.5x	9.2x	7.9x	6.7x	3.9x	3.3x	2.8x	55%	55%
TTM	629	29%	8.3x	5.6x	5.1x	6.2x	4.0x	n.a.	0.7x	0.5x	n.a.	16%	16%
Invensense	907	16%	17.5x	13.7x	10.5x	12.6x	9.0x	5.5x	1.8x	I.6x	1.0x	44%	44%
Synaptics	2,589	33%	12.1x	10.0x	9.0x	9.0x	6.7x	5.5x	I.4x	I.0x	0.8x	34%	38%
Skyworks	15,924	22%	15.9x	13.5x	11.7x	11.4x	9.0x	7.2x	4.5×	3.8x	3.1x	48%	50%
Dot Hill	604	14%	31.4x	22.7x	17.6x	23.4x	17.5x	17.7x	2.4x	2.1x	2.1x	33%	33%
Veeco	926	20%	25.7x	15.9x	12.5x	10.5x	5.9x	3.4x	l.lx	0.9x	0.6x	38%	40%
ARM	20,156	12%	30.7x	26.0x	22.7x	25.3×	21.0x	17.5x	13.0x	11.2x	9.7x	96%	96%
Cypress Semi	3,311	43%	59.2x	10.3x	7.3x	17.7x	7.9x	4.5x	2.2x	I.7x	I.5x	38%	43%
Dialog Semi	3,739	16%	15.5x	13.0x	11.6x	9.2x	7.6x	6.6x	2.3×	1.9x	l.6x	46%	46%
Sierra	673	12%	20.4x	14.9x	11.7x	10.9x	7.2x	4.4x	0.9×	0.7x	0.6x	33%	33%
Electronics	2,000	11%	21.0x	17.0x	14.6x	11.8x	10.0x	8.2x	2.1×	1.8x	l.6x	52%	50%
TransDigm	12,113	12%	25.9x	22.2x	19.2x	15.5×	13.6x	12.3x	7.0x	6.0x	5.6x	53%	53%
ams	2,710	12%	6. x	14.7x	12.6x	11.9x	9.9x	8.1x	3.7x	3.2x	2.7x	55%	54%
CalAmp	576	12%	14.4x	12.5x	11.6x	10.3×	8.2x	5.5x	1.8x	1.5x	1.3x	36%	36%
Ingenico	6,934	12%	22.3x	19.6x	17.0x	13.4x	11.5x	9.8x	3.0×	2.6x	2.3x	45%	44%
Qorvo	8,337	27%	12.3x	10.2x	9.2x	n.a.	n.a.	n.a.	n.a.	n.a.	n.a.	51%	51%
25th percentile		12%	14.7x	l 2.6x	10.6x	9.2x	6.8x	5.lx	1.8x	1.5x	l.lx	36%	38%
Median		16%	20.7x	15.2x	12.5x	11.4x	9.0x	6.6x	2.2x	1.8x	1.5x	48%	50%
- of which median Semiconductors		16%	16.0x	13.6x	11.6x	11.9x	9.9x	7.7x	3.7x	3.2x	2.5x	50%	51%
75th percentile		21%	29.7x	21.3x	17.3x	15.5x	11.5x	8.6x	3.9x	3.3x	2.6x	54%	55%

Note: Semiconductor companies are highlighted

Source: Carnegie Research, Factset 07/09/2015



Key risks

Below we have listed what we view as key risks for the investment case.

EPS sensitivities 17e	Estimate(17e)	EPS i	mpact	in	n %	Likelyhood	l Target	impact
Base case 2017e adj. EPS	23.8							
Key assumption		(+)	(-)	(+)	(-)		(+)	(-)
5% penetration rate	47%	28.2	19.3	I 9%	-19%		67	-67
USD25c ASP	2.50	26.2	21.4	10%	-10%		36	-36
100 bps gross margin	37%	24.6	22.9	4%	-4%		13	-13
5% market share (ex. Apple & Samung	70%	25.5	22.0	7%	-7%		26	-26
Winning Samsung design-win	20% market share	41.6	23.8	75%	0%		268	0
					(N	OTE: SEK pe	r share at	15x PE)

Note: EPS calculations are diluted figures

Source: Carnegie Research

Change in design trends - sensors below the cover glass

There is a constant drive in smartphone and tablet designs for a minimalistic approach. Part of this development has sparked speculation about placement of next-generation sensors. Initially, Apple placed it on the home button and the other OEMs followed. Now we have seen integration on the back and the side. However, many speculate about placement under the non-active front glass. Fingerprint sensors today have proven to work sufficiently only under 'sapphire' glass on the home button. Thus, sapphire glass is used on the home button and another type (i.e. gorilla glass) on the rest of the phone. Many consider sapphire glass too expensive for mass market adoption. However, if sapphire glass is used for the whole screen cover, sensors could be placed under the glass. Technological development may enable sensors below conventional cover glass. However, this has not yet been proven. Idex's presumable work with the glass company Corning may develop a viable product eventually. FPC says it is working on sensor under cover glass, but has yet to show a product. If sensor under cover glass is broadly adopted, without FPC having a viable product, it may shave FPC's market share significantly.

Competitive price pressure

An increasing number of sensor developers are entering the fast growing market and several may be able to produce 'good enough' sensors in a short time. We account for competitive price pressure in our estimates with both ASP and gross margin falling over our forecast period. However, this competition might be more severe than our base case, leading to shrinking margins. With increased competition and relatively little incremental innovation in fingerprint sensors, FPC faces the risk of being commoditised. In such a scenario we could see EBIT margins of 5–10% longer term.

Competing technologies

Competing technologies will pose a risk for FPC, in addition to the above mentioned underglass sensors. We believe FPC will be a strong player in the capacitive space. However, emerging technologies such as 'active thermal' sensors and 'ultrasonic' sensors may pose a risk. We consider the risk posed by Qualcomm's ultrasonic sensor as the most prominent. It has a strong relationship with OEMs and is able to bundle its sensor with chipsets used in phones. If adopted, the technology is likely to be included in high-end smartphones at first and could lead to a higher drop in market share than is reflected in our estimates.

Penetration rates

Our revenue estimates are largely based on penetration rates for fingerprint sensors in consumer electronics. Adoption may prove to be slower or faster than expected.



Potential catalysts

Samsung design win

Samsung holds $\sim 20\%$ of the market excluding Apple. Samsung currently uses Synaptics (Validity) sensors. Samsung is seemingly dissatisfied with the sensor performance and has brought in Egistec to improve the sensor. However, if this solution continues to bring dissatisfied users, FPC stands a chance to win the design.

M&A

FPC is a mono-product company with a semiconductor technology that would fit nicely with a portfolio of the formidable semiconductor houses, e.g. Qualcomm, NXP or Intel. The EV/sales range in large semiconductor transactions over the past three years has been 3.5–4.5x. This translates to SEK307–394 per share.



Company introduction

Fingerprint Cards AB (FPC) is a fab-less company developing fingerprint sensors based on the capacitive (electrical signals) technology. It has built a global market-leading position in smaller touch fingerprint sensors used in most smartphones/tablets. It was the first and currently one of three companies delivering fingerprint sensors to the largest smartphone/tablet producers of the world, excluding Apple. Synaptics, through its subsidiary Validity, is the second, delivering touch fingerprint sensors to Samsung's handsets. With a surge of smartphones entering the global market in 2015, many have picked FPC as their preferred provider of fingerprint scanner components. Consequently revenue in 2015 is guided at SEK2.5bn, up from SEK234m in 2014, or 970% growth Y/Y.

History

FPC was founded in 1997 with its first-generation fingerprint touch sensors. After being listed in 1998, the company developed several generations of its area sensor, secured several IPs and expanded its distribution network into the US and EMEA regions. By 2007 it was the biggest supplier of touch fingerprint sensors for the Chinese banking sector. Demand and focus eventually shifted towards swipe sensors, for which the first commercial order was in 2011. After Apple's launch of the iPhone 5 with a touch fingerprint sensor, focus shifted back to touch fingerprint sensors. FPC got its first design win in the handset segment in 2012. By 2013, 21 mobiles/tablets carried FPC's technology, and by 2014, 18 more smartphones/tablets were introduced with FPC technology.

Business model and value chain

FPC has one of the broadest product portfolios in the industry with 10+ sensor sizes and types. These include sensors for the home button, backside and side button integration that are ready for mass production. FPC recently announced the 1200 series, which will begin with sensors that can read through zirconia glass being ready for mass production in Q3(15), followed by product releases in the near future. We should expect more product launches in this category and we are aware that the company is working on a cover-glass solution.

The lion's share of revenue stems from the smartphone/tablet segment. However, FPC is also present in other vertical markets such as corporate access in the Chinese banking sector. Fingerprint scanners are generally deployed in a number of vertical markets and segments, but smartphone/tablet markets make up the largest addressable market.

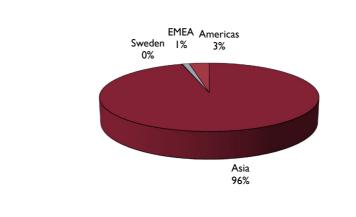


Broad product portfolio

	fingerprint sensor ackside button	Sid	gerprint sensor e Button er or volume button					
Sensor	Mass Production	Sensor	Mass Production	Sensor	Mass Production			
FPC1020	Q2 2014	FPC1150	Q3 2014	FPC1145	Q2 2015			
FPC1021	Q3 2014	FPC1155	Q1 2015					
FPC1025	Q1 2015	FPC1140	Q2 2015					
FPC1022	Q2 2015	FPC1145	Q2 2015					
FPC1035	Q2 2015							
			Sou	rce: Carnegie Ro	esearch, Fingerprint Cards			

Sales are mainly conducted through distributors either as component sales or as project sales in cooperation with the client. The sales are largely conducted on own account or in cooperation with distributors. China is FPC's primary market through its smartphone and banking market. However, Korea, Japan, Taiwan, North America and India are also important.

Fingerprint Cards: Sales by region



Source: Carnegie Research, Fingerprint Cards

The clients are mainly OEMs, product developers and system integrators. Building relationships with the OEMs is key for increasing adoption of FPC's sensors. Sales efforts are also focused more towards module manufacturers (sub-contractors to the OEMs) as the dominant share of sales is components (the sensor area only, i.e. not including the module). This is important to reach a broader market and for the OEMs to capitalise on competition and de-risk production. FPC has entered into cooperation with several module manufacturers, e.g. Crucialtek, O-film and Dreamtech.

As FPC is a fab-less company, all designs are done in-house while production is outsourced. FPC buys cut silicon wafers from SMIC which are then converted into sensor units. The algorithm is partly proprietary and partly sourced from Precise Biometrics of Sweden. Assembly is done through one of the modules mentioned above.



Following the massive increase in demand and design wins, the company has expanded its workforce to 196, of which 115 are full-time employees and the rest are consultants. More than 20 people do marketing and sales and during 2014 the R&D department comprised 80 employees. The R&D personnel, of which 30% has a PhD, largely stems from the telecom industry. The company currently conducts R&D in four locations across Sweden. The idea is to keep the IP close to home. To further integrate development, FPC acquired Anactum Design AB which specialises in ASIC development.

A mixed bag of advantages

We believe FPC's success is attributable to several competitive advantages. The combination of these has made the company a preferred sensor supplier for the most important market, smartphones and tablets. As FPC is one of several fab-less fingerprint scanner producers utilising the capacitive principle, we believe the main reason for success is its proven manufacturing process and experience with client hardware adaption. FPC can deliver a high quality sensor, performing well comparing to peers, at a low price and with integration precision on the back of long experience.

The purpose of this section is to delimit and discuss competition. As demand for swipe sensors is nearly non-existent in today's application, we focus on touch fingerprint sensors.

Does size matter?

Traditionally, law enforcement and governing bodies have relied on easily detectable, rigid and unique fingerprint traits known as minutiae points. Today, high-security fingerprint sensors are too expensive for integration into mass-market devices. This has forced developers to scale down sensor size to make it affordable. Intuitively, smaller sensor size reduces security as one scan reads fewer unique fingerprint traits (minutiae points). However, FPC claims that its highresolution fingerprint scanner can maintain security levels by detecting micro traits (e.g. sweat pores).

While other sensor producers claim that micro pores are not a sufficient measure of identity, micro traits are de facto universally approved by consumer electronics OEMs and the payment industry as a sufficient measure of identity today; e.g. Alipay (Alibaba's mobile wallet solution) is standard with most smartphones in Asia and has approved FPC's sensor for payment (<100mm sq).

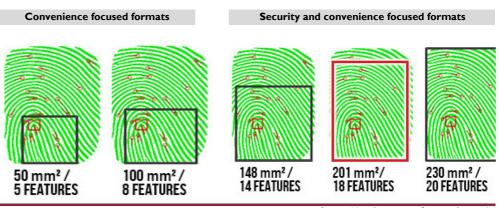
We believe the consumer will neglect whether a sensor is 50mm sq or 144mm sq. The demand for increased security will be driven by the payment industry or other stakeholders of fraudulent transaction and identity thefts. Hence, a 0.001–0.002% false acceptance rate (FAR) is accepted, micro traits are accepted, and small sensors are in demand (more on this discussion on page 32).

Our thesis is that smaller sensors will continue to be favoured in high-volume consumer electronic applications due to their low-price design flexibility given that security levels remain firm. The more risk-averse online banking/payment vendor can easily apply two-step verification without causing meaningful consumer frustration, i.e. fingerprint plus a 4-digit PIN. We therefore believe designers of small sensors, such as FPC, will be favoured by the lion's share of high-volume smartphone/tablet segments. However, we also believe larger sensors will be applied in niche segments with smartphones and tablets for high security application. For stand-alone purposes, we believe larger size sensors will be favoured.

We have split fingerprint sensors into large and tiny formats. Tiny sensors are focused on convenience and customised unit deployment, whereas large sensors focus on the highest possible security (minimum FAR) while maintaining the high convenience level (minimum false rejection rate). Convenience formats range from small 50mm sq sensors featured in Apple's phones to 100mm sq sensors provided by FPC and Synaptics (Validity). Security focused sensor formats range from 144–230mm sq.



Security vs. convenience



Source: Next Biometrics, Carnegie Research

Sensor developers need to reduce sensor sizes to meet format restrictions posed by smartphone and tablet producers. However, our research concludes that tiny formats cannot securely identify a person without the use of micro traits.

Good enough? Lower size equals lower price

If the sensor size is a subjective matter, as proven de facto, then competition should revolve around price versus performance within segments. As mentioned, FPC is strong in smartphones and tablets, while other competitors such as Next Biometrics are strong in higher security applications or stand-alone applications.

In this section we focus our cost analysis on the active thermal principle applied by Next Biometrics and capacitive sensors used by companies such as FPC, Goodix, Synaptics (Validity) and Egistec. We view these as the only viable technologies for mass market to date. Qualcomm has released a new ultrasonic sensor, but it is still in development and we consider it unlikely to be competitive on price. Idex expects to launch a capacitive sensor during H2(15e) (more on page 36).

In brief, we conclude that the polysilicon solution applied by Next Biometrics is and will be the cost leader for the foreseeable future when comparing like-for-like sensor size. However, capacitive sensor designers can reach similar cost when scaling down the sensor. Hence, the capacitive sensors using silicon as base material will not compete in the same segment as larger polysilicon sensors.

Cost breakdown

Most of the cost for a capacitive sensor producer is silicon. Silicon sensors are mostly produced using 8in silicon wafers. The approximate cost of one 8in wafer is ~USD500–600 according to TSMC, but can vary depending on volume and customer relations. An 8in wafer will fit about 450–176 sensors that measure 62–148mm sq. This makes the silicon unit cost USD0.6–1.7. The polysilicon unit cost per sensor is ~USD0.6–1.0 for sensor sizes 144–201mm sq.

Technological advancements over the years have allowed for production of 11.8in wafers, which lowers the unit cost for silicon producers. Industry expert IC Insight estimates that 11.8in wafers will represent 70% of wafer capacity by 2017. A 17.7in wafer will fit 759 sensors measuring 148mm sq. However, the productivity gain from scaling up from 8in to 11.8in and to 17.7in is only 15–20%, according to ICE Corporation. However, unit cost for the silicon sensor element is not likely to be lower than polysilicon.

Illustrated below is an indicative unit cost comparison between the polysilicon sensor and the silicon sensor manufactured at leading silicon foundries such as TSMC and UMC.



Production factor	Polysilicon	Polysilicon	Silicon	Silicon	Silicon	Silicon	Silicon	Silicon
Sensor size (mm²)	144	201	32	62	92	92	92	92
Measures	12x12	4x 4	5.6x5.6	7.8x7.8	9.6x9.6	9.x9.	9.x9.	9.x9.
Wafer size (inch)	n.a.	n.a.	8.0	8.0	8.0	8.0	11.8	17.7
Wafer/sheet size (mm²)	199,920	199,920	31,416	31,416	31,416	31,416	70,686	159,043
Sensors per wafer	1388	840	903	450	295	295	699	1625
Typical cost per wafer/sheet (USDr	840	840	500	500	500	500	947	1761
Commodity cost per sensor	0.6	1.0	0.6	1.1	1.7	1.7	1.4	1.1
Assembly & ASIC cost								
Dicing	0.05	0.05	0.05	0.05	0.05	0.05	0.05	0.05
Extra components	0.30	0.30	0.30	0.30	0.30	0.30	0.30	0.30
Module (FPC, Assembly, etc.)	0.50	0.50	0.50	0.50	0.50	0.50	0.50	0.50
Sensor coating	0.09	0.09	0.09	0.09	0.09	0.09	0.09	0.09
Algorithm	0.20	0.20	0.20	0.20	0.20	0.20	0.20	0.20
other (Testing, Packaging, etc)	0.30	0.30	0.30	0.30	0.30	0.30	0.30	0.30
Total assembly costs	1.44	1.44	1.44	1.44	1.44	1.44	1.44	1.44
Total manufacturing costs	2.0	2.4	2.0	2.6	3.1	3.1	2.8	2.5
Production yield	95%	95%	95%	95%	95%	95%	95%	95%
Total yielded cost	2.2	2.6	2.1	2.7	3.3	3.3	2.9	2.7
Margin	40%	40%	40%	40%	40%	40%	40%	40%
Minimum selling price	3.59	4.29	3.50	4.47	5.50	5.50	4.90	4.43

Indicative cost breakdown for a LTPS sensor vs. silicon sensor (USD)

Source: ICE corp, Gartner, NEXT, TSMC, Carnegie Research

The assumptions used in the calculations above rely on ICE Corporation statements about productivity gains from increasing wafer size and Next Biometrics' statement about unit price. Silicon sensor producer assembly and ASIC costs are based on Next Biometrics' industry insight. The assumptions are:

- 20% productivity gains from increasing wafer size.
- USD1.0 polysilicon unit price.

The most important cost is the actual raw material base component, the silicon. Assembly and ASIC costs can fluctuate among producers. Our cost analysis shows that silicon 148mm sq sensor costs will reach only USD2.8 compared to a USD0.6 for 144mm sq polysilicon sensors. Therefore it is unlikely that silicon producers can compete with the polysilicon sensors on price in the foreseeable future if producing the same sizes.

However, smaller silicon sensors enable producers to reach commodity unit costs as low as USD0.6 when reducing the size to 32mm sq. FPC delivers sensors from 92mm sq with its old 1020 model to as low as 32–62mm sq. As silicon is the main cost component, COGS effectively scales proportionally with sensor size.

FPC states that it has an ASP of USD3.0–3.5 which translates into a unit cost of USD1.8–2.1, which coincides well with the calculations above. Keep in mind that FPC largely sells the fingerprint component only, which enables reduced 'assembly and ASIC cost', as displayed above.



Sensor producers have made statements about "lower" production costs, although no specific production costs or technological improvement have been mentioned. But Idex's off-chip solution looks promising and will start sampling in H2(15). This sensor claims to use a smaller amount of silicon. We view all sensors sizes below USD4 as mass market applicable. FPC has an ASP of about USD3.0–3.5 (~50% module and 50% sensor head only).

Competition among small capacitive sensors

Capacitive and active thermal technologies are the only ones eligible for mass market currently. The only designer using the active thermal technology is Next Biometrics and its active thermal principle. Other technologies are currently inapplicable for mass market (see page 36). Next Biometrics focuses only on larger sensor sizes, which has rendered them less attractive for size sensitive application such as smartphones and tablets. Competition between the two technologies is likely in notebooks. However, fingerprint scanner adoption in notebooks is lagging for reasons discussed on page 30.

Competition among capacitive sensor designers is more diffuse. Here we focus only on competition in the small touch fingerprint sensors. Several designers are able to produce 'good enough' sensors. Today there are at least five significant designers, namely Fingerprint Cards (Sweden), Goodix (China), Egistec (Taiwan), Synaptics (US) and Silead (China). However, other designers are entering the market, but with no material traction yet, such as Idex, Qualcomm, Vkansee, BYD, FocalTech and MicroArray trying to grab a share in the fast growing market.

We believe these factors have determined FPC success to date, rated by importance:

- First mover advantage proven production and technology track record.
- Attractive price versus performance.
- Good design flexibility due to broad portfolio and small size together with shape and colour optionality.
- Accumulated integration experience which reduces time to market for OEMs.

Company	Country	Technology	Mass production
Fingerprint Cards	Sweden	Capacitive	Yes
Goodix	China	Capacitive	Yes
Synaptics (Validity)	USA	Capacitive	Yes
Egistec	Taiwan	Capacitive	Yes
Next Biometrics	Norway	Active Thermal	Yes
Silead	China	Capacitive	No
IDEX	Norway	Capacitive	No
Qualcomm	USA	Ultrasonic	No
Vkansee	China	Optical	No
BYD	China	Capacitive	No
FocalTech	Canada	Capacitive	No
Microarray	China	Capacitive	No

Competitive landscape



New players and reading through glass

Other capacitive sensor designers are planning to enter the market and several are sampling sensor chips, notably Idex of Norway. Another factor to consider is the ability to integrate sensors under the cover glass of smartphones and tablets.

Goodix is sampling this solution in collaboration with panel producer TPK. Idex has showcased this technology and aims to start sampling by Q4(15). Recently, Idex announced collaboration with a Fortune 500 distributor, which we read as being the glass manufacturing company Corning. If so, it seems Idex has been chosen as the viable sensor technology for in-glass sensor solution. Corning is the manufacturer of the popular 'gorilla glass' used in many smartphones today.

FPC states it is possible to read through cover glass with its chips; however, no applicable solution has been announced to date. Management has also stated that there is demand for such a solution, but nothing has materialised mainly due to performance issues. FPC recently released a new sensor series able to read through zirconia glass and we should expect more announcements in this product series.

Qualcomm's ultrasonic sensor also claims to read through both cover glass and other material. We believe the standard for sensor placement is set by smartphone 'trend-setters', most notably Apple. Hence, a move to a functioning in-glass solution could shave FPC's market share if the company cannot provide a good solution.

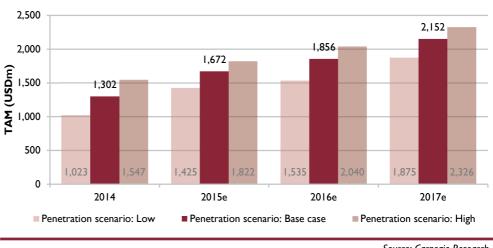


Market overview

The prospective size of the total addressable market is undoubtedly big. FPC is strong in the smartphone and tablet segment. Opportunity persists in the notebook segment and prospective application in payment cards is in development. In traditional markets where security is paramount and format applicability is less prioritised we believe companies with inherent lower production costs, i.e. Next Biometrics, stand stronger. In this section we will focus on the consumer electronics market.

Consumer electronics

We calculate the current total consumer electronics total addressable market for FPC is USD1.67bn in 2015e. Underpinned by trends such as the convergence of physical and digital point-of-sale systems, online banking, cloud computing and 'the internet of things', we believe the total addressable consumer electronics market in 2017 will be USD2.15bn (consumer electronics market only). We view the fingerprint sensor market as two principal segments: consumer electronics and the traditional market (e.g. access control, time and attendance, government, and law enforcement).



Fingerprint sensors: Total adressable consumer electronics market

Source: Carnegie Research

Consumer electronics is the growth market for fingerprint technology. The addressable market value will depend on how fast the market adopts the fingerprint reading standard. To assess the addressable market for FPC, we have built a forecast model based largely on industry experts and excluded devices running on Apple's OS. We have also applied several scenarios of adoption and ASP development described below.

Payment cards

Opportunity may reveal itself in integration of fingerprint sensors in credit cards and debit cards. However, there is little traction as yet. The challenge has been integrating a silicon sensor into flexible plastic card while maintaining durability of the sensor and of the card itself. FPC expects development in this area to materialise in 2016 at the earliest. The company has an ongoing project with payment card or smart card designer of Norway on behalf of Mastercard. Zwipe announced on 24 June that it had added 10 channel partners and is experiencing increasing demand for its solutions.

Idex of Norway has announced an agreement with a "global payments company" for the development of biometric payment cards. It has also successfully demonstrated its flexible sensor in an ISO-compliant flexible card. About 14.4bn payment cards were issued in 2012 (Nielsen Report 2013). This number is expected to grow to 20.6bn by 2017e. In addition, the average replacement rate of payment cards is $\sim 2-3$ years. If penetration reaches (say) 10% by



2017e with a sensor ASP (sufficiently low at ~USD100–150 per sensor (sensor head only), this represents an addressable market of USD1.4bn–2.2bn. We have not added payment card volumes to our estimates.

Traditional verticals

The traditional verticals are hard to quantify, but sources lead us to believe this is a multi-billion dollar market. Industry experts estimate the potential for fingerprint solutions in the banking sector alone to be ~USD1.0bn-1.2bn. NEXT estimates the traditional market to be 9m-12m sensors sold per year in 2014. As cost per unit has been reduced significantly in recent years, additional growth will come from replacement of conventional security measures such as PIN codes and OTP generators. Due to FPC's focus on consumer electronics and, in our view, less competitive position in traditional segments, we will focus on consumer electronics in this report.

Consumer electronics market

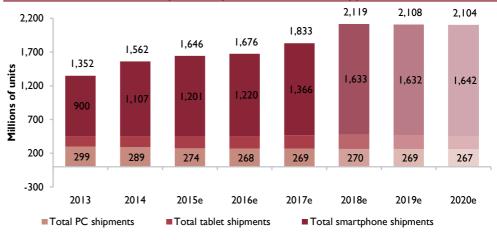
We have divided the consumer electronics market into three categories: smartphones, tablets and notebooks (including accessories). For the purpose of assessing market potential for fingerprint sensors, we will provide an outline below before assessing growth potential.

When estimating FPC's addressable market we start with forecasting growth in personal electronics such as smartphones, tablets and notebooks. Based on statements by manufacturers and current trends, we firmly believe that fingerprint reader integration will become the new standard. However, this applies only to high- to mid-end and niche corporate models in the short term. Here we are primarily seeking to:

- Assess the market trend for smartphones, tablets and notebooks.
- Delimit the market to segments outside Apple OS devices, as Apple Inc. uses proprietary sensor solutions (Authentec).
- Assess penetration of biometric security solutions.

Total addressable market (TAM)

We have built a forecast model based on estimates by leading industry experts IDC and Gartner. We have excluded products from Apple. We expect smartphone tablet and PC shipments to grow from 1.35bn in 2014 to 1.83bn by 2017e and 2.10bn by 2020, a CAGR(15–20e) of 5.0%.



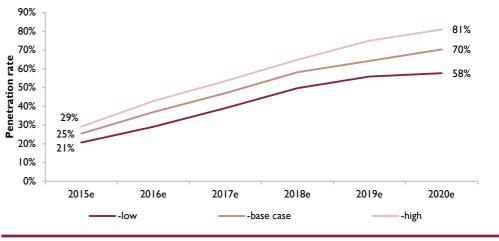
Global PC, Tablet and Smartphone shipment volume, excl. Apple

Source: Gartner, IDC, Carnegie Research



Not all devices will have fingerprinting technology. Therefore we have outlined three scenarios for fingerprint technology adoption. The adoption rate will depend on several factors including unit price, economic development, and growth contribution by cloud computing, online banking and the internet of things. In our three penetration scenarios we outline three adoption rate trajectories.

The market value will depend on how fast it adopts fingerprint reading. Our base case assumes 41% blended penetration in 2016e. In the low and high penetration scenario we pencil in total adoption of 33% and 51% respectively.



Total blended penetration rate (%), excluding Apple

Average selling prices

We do not believe the USD3–4 unit price for small sensors used today is a limiting factor. Assessing the bill of materials (BOM), leading industry sources state that sensor integration is viable only if the additional cost is below USD4. Illustrated by the table below, the implied cost increase for fingerprint integration is below USD4 if we assume the cost of other sensors is in the area of ~USD1.0, below the USD4 threshold.

Samsung Galaxy S6 BOM	Cost (USD)
Display	\$ 85.00
IC content	
Apps processor	\$ 29.50
Baseband IC	\$ 15.00
Memory	\$ 52.50
Powermanagement IC's	\$ 5.40
RF/PA section	\$ 12.50
User interface IC's	\$ 9.95
Sensors (fingerprint, gyroscope etc)	\$ 4.80
Modules (camera, wlan battery)	\$ 29.00
Other noteworthy items	
Box contents	\$ 6.20
Other mechanical / electro-mechanicals	\$ 35.00
Convertion cost	\$ 5.60
Total bill-of-materials	\$ 290.45
Retail value	\$ 799.99
-margin (%)	36.3%

Source: Carnegie Research, IHS research

Source: Carnegie Research



However, we are seeing handsets with integrated fingerprint sensors selling as low as USD120 which would imply a total sensor cost of ~USD1.5 using the same ratio. Today FPC sells for ~USD3.5–4.0 (full module/LGA/BGA).

Manufacturers us Manufacturer	sing touch fingerprint sensors Model	Indicative Price USD	Sensor supplier
Tier I	hodel		
Apple Iphone	5s, 6, 6plus (all)	600.0	Authentec
HTC	Max, One M9(+)	229.0	Fingerprint Cards
Samsung	S5, S6, Note4, Note Edge	550.0	Synaptics (Validity)& Egistec co-lab
Huawei	Ascend Mate, Honor 7, MaiMang	600.0	Fingerprint Cards
Sony	Xperia z5	800.0	Fingerprint Cards
Lenovo	Vibe series	300.0	n.a.
Sub-tier			
Alibaba/Phillips	Aurora i966	230.0	Egistec
Coolpad	TipTop pro, Dazen	160.0	Fingerprint Cards
Disney	Various	n.m.	Fingerprint Cards
Elphone	_P 7000	220.0	Fingerprint Cards
Fujitsu/Docomo	Arrows series	240.0	Fingerprint Cards
Gigaset	ME- series		Fingerprint Cards
Meizu	MX5	ТВА	Fingerprint Cards
iBerry	Auxus	150.0	Fingerprint Cards
Kingzone	ZI	180.0	Fingerprint Cards
Konka	K5F	160.0	Fingerprint Cards
LeTV	LeMax	TBA	Fingerprint Cards
Meizu	MX5	450.0	Fingerprint Cards (Formerly Goodix)
Mlais	Note Pro	150.0	Fingerprint Cards
Newman	Button CM810	215.0	Fingerprint Cards
Nextbit	Robin	tba.	Fingerprint Cards
Oneplus	Oneplus 2	330.0	Fingerprint Cards
Орро	N3	650.0	Fingerprint Cards
Otium	Z4	190.0	Fingerprint Cards
Elephone	P3000	550.0	Fingerprint Cards
Qiku	Q-series	164.0	Fingerprint Cards
Saygus	V2	550.0	Fingerprint Cards
Swipe	Sense	120.0	Fingerprint Cards
Timmy	E88	180.0	Fingerprint Cards
Vifocal	C1000	130.0	Fingerprint Cards
Toshiba	G500 &G 900 series	449.0	Fingerprint Cards
Xolo	Q2100	140.0	Synaptics (Validity)(?)
ZTE	Axon series	450.0	Fingerprint Cards
ZUK	ZI	270.0	Fingerprint Cards

Note: includes both area and swipe sensors

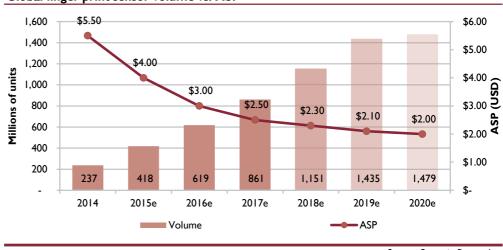
Source: Carnegie Research, various industry sources

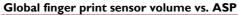
ASP is inversely correlated with volume, competition and technological advancement. As such we believe sensor price will continue to be pressured toward USD2 and below for the coming generations of affordable low-end smartphones out of Asia. We believe smartphone prices will continue to drop as smartphone penetration increases in low-cost countries. Companies such as Telenor point to an inflection point for mass market adoption in these countries around USD50–100 and below. This means the total BOM should be less than USD45–80.

For fingerprint sensor integration in such low-end smartphones we would need to see ASP down to USD1.5–2.0 before being viable. This should be possible through economies of extreme scale, pressured margins across the value chain through competition, and technological advancement in wafer production and more efficient component integration.

Carnegie

Please note that we use full module cost when referring to ASP. We are aware that some manufacturers are selling only the sensor component for less than USD3.0 at the moment while module and assembly are sourced through third parties, e.g. FPC. Hence, the general ASP used in this calculation is slightly higher for 2015 compared to the USD3.3 used for FPC estimates.







FPCs addressable consumer electronics market	2013	2014	2015e	2	2016e	2017e		2018e	2019e		2020e
Total PC shipments	315	308	293		288	290		292	291		291
-of which non iOS	299	289	274		268	269		270	269		267
Total tablet shipments	228	230	235		263	276		286	269		259
-of which non iOS	153	166	172		188	198		216	207		194
- of which non iOS & Samsung	136	126									
Total smartphone shipments	1,054	1,299	1,437	1	,435	1,579		1,873	1,902		1,932
-of which non iOS	900	1,107	1,201		1,220	1,366		1,633	1,632		1,642
- of which non iOS & Samsung	584	791									
Total Units shipped	1,597	1,837	1,964	1	,986	2,145		2,451	2,463		2,482
- of which iOS	245	275	318		311	312		332	355		378
- of which Samsung	333	356	329		335	367		424	422		421
- of which non iOS units	1,352	1,562	1,646		1,676	1,833		2,119	2,108		2,104
- of which non iOS & Samsung	1019	1206	1317		1340	1466		1695	1687		1683
Total fingerprint sensor penetration rate											
-low		11%	21%		29%	39%		50%	56%		58%
-base case		15%	25%		37%	47%		58%	64%		70%
-high		19%	29%		43%	53%		65%	75%		81%
Total adressable volume by segment (base case)											
Smartphones		221	372		549	751		1,062	1,143		1,232
Tablets		12	43		56	69		97	104		107
PC's		3	3		13	40		74	107		140
Total		237	418		619	861		1,233	1,354		1,479
Total fingerprint sensor units sold (non-iOS)											
-low		177	339		487	714		1,052	1,177		1,213
-base case		237	418		619	861		1,233	1,354		1,479
-high		296	479		716	979		1,373	1,581		1,703
Assumption: Sensor ASP (non iOS market)											
-low		\$ 5.78	\$ 4.20	\$	3.15	\$ 2.63	\$	2.42	\$ 2.21	\$	2.10
-base case		\$ 5.50	\$ 4.00	<u> </u>	3.00	\$ 2.50	\$	2.30	\$ 2.10	\$	2.00
-high		\$ 5.23	\$ 3.80	\$	2.85	\$ 2.38	\$	2.19	\$ 2.00	\$	1.90
Value of FPC's adressable consumer electronics marke	et (USDm)										
Penetration scenario: Low		1,023	1,425		1,535	1,875		2,541	2,595		2,546
Penetration scenario: Base case		1,302	1,672		1,856	2,152		2,836	2843		2,958
Penetration scenario: High		1,547	1,822		2,040	2,326	_	2,999	3,154	_	3,236

Smartphone volumes

Fingerprint integration in smartphones was started by Apple and Samsung. The smartphone market is high volume with annual sales of 1,300m units in 2014, according to IDC estimates. The market is characterised by long lead times and focus on format applicability. Lead times are likely to be 6–9 months according to several sources.

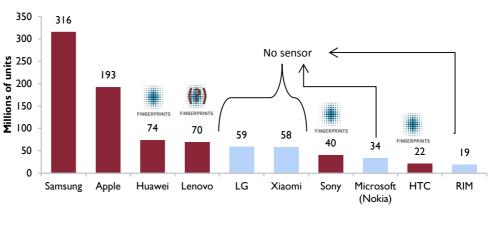
The biggest challenge for phone manufacturers is how the phone should look to be a commercial success. Technological progress has made the fingerprint sensors small enough to fit smartphones. Higher requirements are driving the smartphone market towards more secure solutions such as small area and away from swipe sensors.

Tier 1 smartphone makers are most likely to be the first to adopt a fingerprint sensor. We consider Tier 1 the top five (top six including Apple) as Tier 1. Some 60% of the market in 2014 for smartphones was Tier 1 (Apple, Samsung, Huawei, Lenovo, LG and Xiaomi). Among the top six, Apple, Samsung and Huawei have integrated an fingerprint sensor in the flagship models. This represents 50% of total volume. If fingerprint sensors are the new standard for these suppliers it implies ~640m sensors sold per year or ~580m excluding iOS. Lenovo and



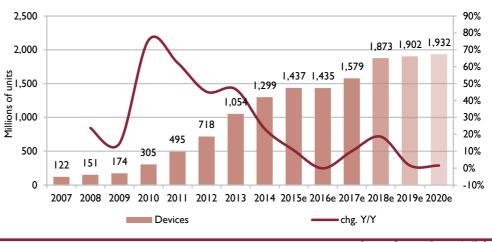
Sony released new products with a fingerprint sensor in August 2015. Other global players such as LG, Microsoft/Nokia and Xioami are still sitting on the fence (Xiaomi is rumoured to include the sensor in its new flagship model).

At USD4.0 per unit, Tier 1 implies a USD2.3bn market alone. In addition, brands such as LG, Microsoft/Nokia and Xiaomi are likely to adopt the fingerprint sensor due to its massive popularity and requirement for mobile wallet initiatives such as Alipay in Asia (Xiaomi is rumoured to be including a fingerprint sensor in its next flagship model).



Global smartphone shipments: Top 10 vendors 2014/2013, by volume

The global smartphone market is expected to grow by a CAGR of 6.1% in 2015–17e according to data compiled by Gartner and IDC. We expect 1,932m units to be shipped in 2020, up from 1,300m units in 2014. Industry experts estimate 2018e to be the inflection point of mass adoption due to affordable smartphones entering the market.



Global smartphone shipments

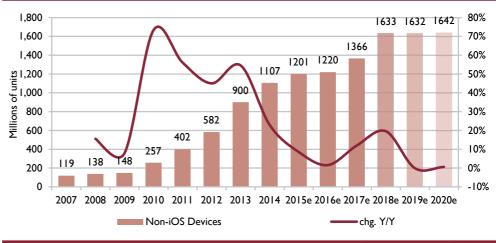
According to IDC, Apple iOS had ~15% of the total smartphone market in 2014, and is expected to maintain 15% by 2020. Apple's market share in the US far outweighs the market share in China, by 36% to 14%. As most growth is likely to come from the Asia Pacific region, we expect the growth rate in android-based devices to be faster than iOS devices.

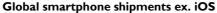
Source: Carnegie Research, IDC

Source: Carnegie Research, IDC



The total number of non-iOS smartphones shipped in 2014 was 1,107m. By extrapolating the market share we estimate that 1,642m non-iOS devices will be shipped in 2020; CAGR 6.5%.



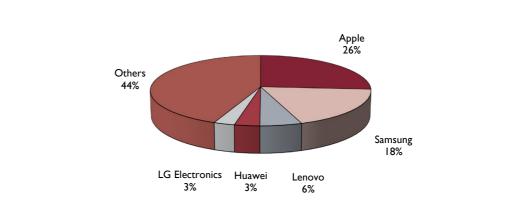


Tablet volumes

When fingerprint sensors are made sufficiently cheap and become standard in smartphones, they is also likely to become standard in larger tablets. We believe that one sensor will be fitted to an entire ecosystem to increase uniformity. For example, Samsung is likely to have the same sensor in the phone and tablet.

In 2014, a total of 230m tablets were shipped. According to Gartner, tablet shipments will reach 259m units in 2020, a CAGR of 2%. Estimates from industry experts have been cut severely in recent years. The popularity of the tablet was reduced by the increasing size of smartphones, or 'phablets', and the increasing portability of notebook computers.

Global tablet market share HI(15)

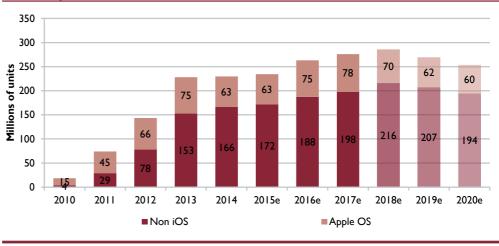


Source: Carnegie Research, Gartner

Source: Carnegie Research, IDC, Gartner



IOS's market share in 2014 was 28%. IDC expects a decline in Apple's market share to 23% in 2020, as Android devices have a stronger foothold in Asia. If we assume that Apple's market share will fall proportionately over the forecast period, 260m non-iOS tablets will ship in 2020.



Global shipment of tablets 2010-2020e

Notebooks

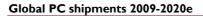
In June 2013, Microsoft demonstrated a touch fingerprint sensor together with a beta version of Windows 8.1 which will be standard for authentication, enhanced security, and to improve ease of use. Our understanding is that it will push the entire Windows ecosystem towards biometric identification. This entails a second growth opportunity in addition to the traditional market. Today, there is no significant adoption of fingerprint sensor in notebooks. Our channel checks report that notebook integration is less appealing due to the innate support for SPI from sensor modules. This is a standard commonly used in smartphones and light applications. Notebooks use USB. Hence, by integrating fingerprint sensor modules today, OEMs have to use a USB converter which by itself adds another USD1–2 to the BOM. However, we expect notebook adoption to follow increasing consumer adoption of fingerprint sensors through other consumer electronics.

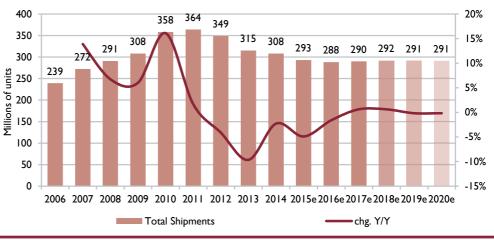
There are about 1.5bn users of the Windows OS today. Even though the market is stable, there is significant turnover of stock. According to Microsoft, 100m new licences for Windows 8 were sold during the first six months after the launch. Furthermore, when Windows establishes a new standard it has a tendency to spread to other ecosystems. If we include all devices with the potential to be fitted with a fingerprint sensor in the broad Windows ecosystem, it is 1.4bn–2.0bn devices. This includes notebooks, desktop computers, gaming consoles and accessories.

PC and notebook sales have suffered from substitution to tablets. Sales fell on average 7% in 2011–13. However, notebooks will contribute with significant demand in the coming years as more than 300m units are sold annually. Global PC shipments totalled 316m units in 2013, versus 351m 2012, and are expected to increase slightly from this level.

Source: Carnegie Research, IDC

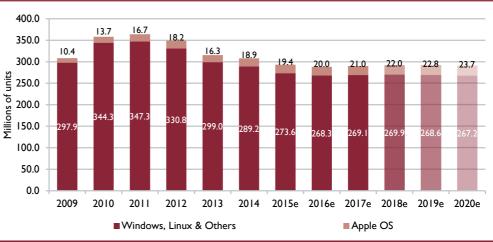






Source: Carnegie Research, IDC, Gartner

Apple holds a relatively small market share in the PC market. For our forecast we have assumed a stable market share for iOS, or Apple, based systems.



Global PC shipments, by OS

Source: Carnegie Research, IDC, Statcounter



Fingerprint technology

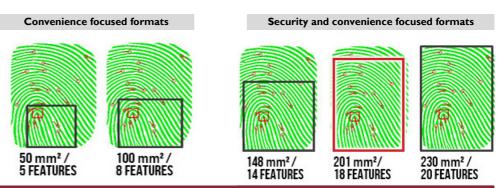
We have divided the fingerprint sensor into two segments: convenience-focused and securityfocused. Convenience-focused formats are small and provide a simple alternative to username/password combinations used for accessing personal devices. Security-focused formats are larger and provide a range of credible references as they are used by corporations for access control, time and attendance, and point of sales purposes.

There are currently three primary uses of biometric data for high security purposes:

- Domestic security and law enforcement: i.e. automated fingerprint identification systems (AFIS), capable of rapidly determining an individual's identity, previously used identities, and past activities.
- Enterprise and e-government services: administration of people, processes and technologies.
- Personal information and business transactions: business plans that meet customer demands for services at any time, from any location and through many communication devices.

The convenience segment has focused primarily on replacing username/password combinations where very high security is not necessary. To our knowledge, these are not accepted by the payment industry as stand-alone user verification.

Security vs. convenience



Source: Carnegie Research, NEXT

Security versus convenience – does size matter?

Sensors come in different sizes and shapes. According to the Federal Information Processing Standards (FIPS) publication 201, a sensor must measure at least 211.2mm sq, produce 500 pixels per inch (PPI), and 8-bit per pixel is to be approved for government use. This effectively disqualifies most fingerprint sensors. However, compromises can be made for a one-to-one matching purpose unlike one-to-many, such as the AFIS (automated fingerprint identification system) used by the US government.

Parameter	Requirement
Capture size	≥ 12.8 mm wide ≥16.5mm high
True optical or native re	esolution ≥ 500 ppi sensor detector row and column direction
Resolution scale	490 ppi to 510ppi sensor detector row and column direction
Image type	Capability to output monochrome image at 8 bits per pixel, 256 gray-levels (prior to any compressic
	Source: Campaie Research FIPS

To achieve a certain level of security a sensor must read enough unique traits on one finger to avoid false acceptance.

Next Biometrics, one of FPC's competitors, firmly states that lower sensor size equals lower security. This is based on the assumption that a smaller sensor can detect fewer unique fingerprint traits (minutiae points) in one scan. However, this is counteracted by claims from several other manufacturers that the use of micro traits (i.e. minor unique traits such as sweat pores) enables equal security. Evidently, micro traits are changing with time and wear. Thus, some argue it should not serve as a reliable measure of identity. If these micro traits are changing, the false rejection rate should increase and potentially build consumer frustration. We can see this as a problem in stand-alone fingerprint scanner solutions. However, for applications such as smartphones, the consumer can easily enrol a new set of fingerprints.

The facts tell us that micro traits are universally approved by consumer electronics OEMs and by the payment industry as a sufficient measure of identity; e.g. Alipay (Alibaba's mobile wallet solution) is standard with most smartphones in Asia and has approved FPC's sensor for payment (>100mm sq). The FIDO alliance, a member organisation of fingerprint designers and counterparts, is developing a standard for sensors. However, given that the stakeholders are several designers, we doubt it will be ground-breaking or exclusive.

The development in FPC's revenue mix tells the same story. Sales of smaller sensors are increasing as FPC manages to maintain security levels (using micro traits) while scaling down the sensor. Smaller sensors are cheaper and yield greater design flexibility and are thus favoured by OEMs in consumer electronics. FPC's management points to 0.001–0.002% FAR as the accepted security level. This means one falsely approved fingerprint in 100,000 or one in 50,000.

We believe the consumer will disregard whether a sensor is 50mm sq or 144mm sq. The demand for increased security will be driven by the payment industry or other stakeholders of fraudulent transaction and identity thefts. Hence, 0.001–0.002% FAR is accepted, micro traits are accepted, and small sensors are in demand.

The question if this will change is highly relevant. Increasing government, corporate and media attention is focusing on online security, most notably the data breaches at Home Depot, Kmart, Staples and JPMorgan. Hence as transaction volumes increase and identity theft and frauds increase, we might see demand shift towards larger sensors.

Our thesis is that smaller sensors will continue to be favoured in high-volume consumer applications due to their low-price design flexibility given that security levels remain firm. The more risk-averse online banking/payment vendor can easily apply two-step verification without amassing huge consumer frustration, i.e. fingerprint plus a 4-digit PIN. We therefore believe designers of small sensors, such as FPC, will be favoured with the lion's share of high-volume smartphone/tablet segments for the time to come. However, we also believe larger sensors will be applied in niche segments with smartphones and tablets for high security applications.

Can algorithms compensate for size?

Various sensor algorithms have been around for many years. Minutiae-based systems have been the dominant solution in commercial systems and quality critical open mass-market applications. Pattern-based algorithms have primarily been applied to small format sensors.

Algorithms have improved gradually over the past decade, but they cannot replicate the security that a solid picture can. No algorithm can compensate for the fact that a small sensor will capture a smaller portion of a finger. However, algorithms can improve the scanner effectiveness and speed when evaluating the unique minutiae or micro traits.



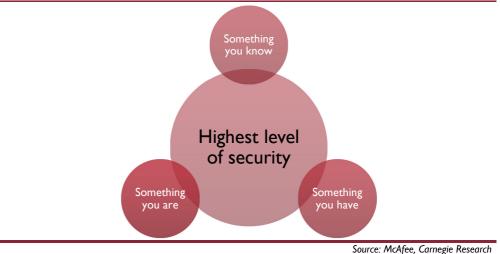
Why fingerprint security?

The most common approaches to identification to date have relied on access cards and username/password combinations. These methods are insecure for users and organisations.

There are three levels of authentication:

- Something you have (token a key, card or badge).
- Something you know (password, PIN, a memory).
- Something you are (biometric trait fingerprints, iris, voice etc.).

Security levels

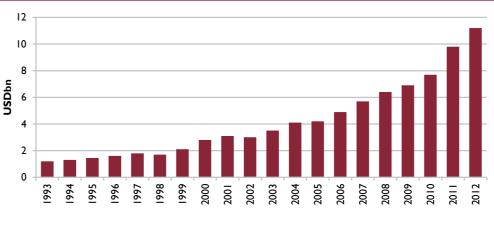


Passwords are the most common identification method today and are universally recognised as a liability as the phrases are fairly easy to guess using software, or to steal. In most cases a person has several passwords which for organisational matters and ease of remembering are simplified. Single-sign-on services that gather all passwords under one have gained popularity, making it possible for criminals to acquire all passwords by acquiring one. Passwords' apparent lack of security was recently highlighted when the 'heartbleed' bug was discovered. The bug was a scripting error discovered in the OpenSSL cryptographic software. This software is used by 66% of all web servers and allowed others to retrieve information such as passwords and other sensitive information untraced.

Since the beginning of 2004, reports of card fraud have exploded and banks are looking for ways to protect the online banking channel. Different approaches have been implemented to cope with various fraud schemes. These methods include:

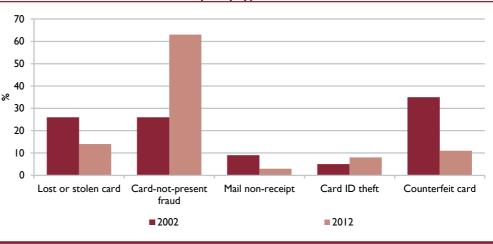
- PIN codes.
- One-Time-Password (OTP) sheets and tokens.
- Transaction specific OTPs.
- OTP by SMS.
- Smart cards and USB tokens.

A study by Datagenics and McAfee found that 10% of all PIN codes can be guessed in one attempt and that 17% of people in Europe have been victims of credit card fraud. The average victim lost USD1,800. The total amount of fraud committed through credit card related crimes was USD650m in the UK alone and USD11bn (+14.6% Y/Y) worldwide. The fraud rate (as a percentage of total transaction volume) is slightly above 5bps. There is an apparent need for better solutions.



Global card fraud losses

The majority of frauds relate to card-not-present (CNP) frauds. CNP transactions happen when a purchase is made through a physical or online merchant while the cardholder is not present. Often the merchant has no good way of identifying the person or transaction.





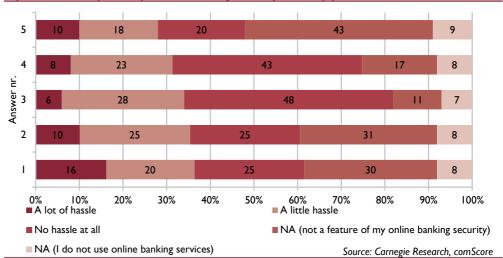
OTP generators (token, sheet, SMS or calculator) and smart cards are the predominant way of authenticating transactions. The smart card is used together with a pin code and requires a smart card reader. Both methods are commonly viewed as the best fraud prevention methods to date.

The hardware and software required to facilitate use of the smart card or OTP generator are either too low in terms of security or offer too little in the way of convenience. In the UK, an average of 33% of banking clients feel that the security measures in place are "a lot of hassle" or "a little hassle". Hence there is demand for a more convenient solution.

Source: The Nilson report(issue 01 2013)

Source: Carnegie Research, UK card Association





Opinion: Hassle posed by online banking security,2013, by procedure

Option Question

- I Needing to verify my security details ovr the phone before I can access my account
- 2 Needing to wait for a password to be send to me via text message before I can log in
- 3 Needing to answer additional security questions such as "first pet's" name
- 4 Needing to use a pin number/card reader for online banking
- 5 Needing to have a token generator (keyfob with seperate password number)

Source: Comscore

To achieve the highest level of security one would have to provide authentication level no. 1 through 3, e.g. something you have, know and are. Biometric traits such as retina, face, voice and hand geometry are the alternative to fingerprints. Technology reading these traits has been unsuccessful due to a high false acceptance rate (FAR) and high costs. A reader of these traits can cost USD10–500 and usually requires integration costs. These solutions have been implemented only at especially secure locations where authentication by fingerprint is not enough.

Thus the only cost-efficient biometric reader today is the fingerprint reader. A fingerprint reader approved for authentication, issued to every online and mobile-bank user seems viable. In addition, customers are turning away from alternative banking services such as payday loans, check-cashing services, or a pay-roll card and towards online solutions. In our view, this is the major driver for fingerprint sensors.

Fingerprint sensor technologies

The analysis of fingerprints for matching purposes requires comparison of print pattern features. They are aggregates of ridges and minutiae points. The three basic ones are arch, loop and whorl. The major minutiae are ridge endings, bifurcation and short ridges. A fingerprint sensor captures a digital image of the pattern which is processed to create a biometric template.

Several fingerprint reading technologies have been developed over the past decade. Below we will explain the technologies in a mass market context.



Optical

Optical fingerprint imaging involves capturing a digital image using a small lens and lightemitting phosphor layer that illuminates the surface of the finger. A scratched or dirty touch surface can cause a bad image of the fingerprint and it is relatively easily fooled by a 'fake finger'. In addition, the nature of this technology does not allow it to be integrated into small devices. Hence it is not viable for mass market production. However, unlike capacitive sensors, optical sensors are not susceptible to electrostatic discharge damage (ESD), which is why this technology is found in larger applications and static installations.

Ultrasonic sensors

Ultrasonic sensors use high-frequency sounds to penetrate the outer layer of the skin where the reflected wave measurements form a digital image of the finger. This provides verification of a live finger. This makes the FAR and false rejection rate (FRR) low. Traditionally, this technology has been slow, expensive, bulky, and too data intensive for most access control applications. However, Qualcomm has introduced a new ultrasonic sensor, labelled SenseID, to be integrated into its Snapdragon chipset used by many phone vendors today. This technology looks promising as it can read through most materials and with higher security than common tiny touch fingerprint sensors as it produces a 3D image of the finger (versus 2D from capacitive sensors). Qualcomm expects snapdragon chipsets with support for this technology to be on the market by H2(15).

Capacitive sensors

These sensors use capacitor plates to image fingerprints. Skin is conductive enough to produce a capacitive coupling with an individual element on the array. Ridges being closer to the detector have higher capacitance and valleys have lower. They can be sensitive to ESD but insensitive to ambient lighting and are more resistant to contamination than some optical designs.

We differentiate between passive and active capacitance: active capacitance uses a charging cycle to apply voltage to the skin before measurement takes place, passive sensors do not. Active capacitance sensors measure the ridge patterns of the dermal layer like the ultrasonic method. Again, this provides low FAR and FRR.

RF and pressure sensors

RF sensors use a low frequency signal that is applied to the finger and then read by the detector array, with each pixel operating like a tiny antenna. This technology has the same benefits as an ultrasonic sensor. RF technology is often deployed together with the capacitive principle.

Pressure sensors can be very thin. There are two types, conductive film detectors and microelectro-mechanical devices (MEMS). Conductive film detectors use a double-layer electrode on flexible film. MEMS is a newer technology that uses tiny silicon switches on a silicon chip. At the moment pressure sensors are difficult to coat and have a specialised manufacturing process making it too expensive for mass market viability.

Passive thermal sensors

Thermal sensors can convert changes in temperature into a specific voltage. When a finger touches the sensor, it reads the temperature in the ridges. An image is created by the skin-temperature ridges and the ambient temperature measure for valleys.

A drawback is that the temperature change is dynamic and it only takes about a tenth of a second for the sensor to reach the finger's temperature. The sensor requires heating to create a temperature difference of at least 1 degree centigrade.

Active thermal sensor

The active thermal principle has solved the problem related to temperature difference in the conventional thermal sensor. A low power heat pulse is applied to each sensor pixel over a short period of time and a response is measured. This is quite large and different for pixels in proximity to a finger's ridge or valleys. The proprietary ASIC reads, processes and communicates the signals into a high resolution image to the host system.



Mass market production - what are the determinants?

We have identified four characteristics that enable fingerprinting for mass market application. By mass market we mean the possibility of integration into devices using or applying authentication at some level including notebooks, laptops, phones, tokens and corporate access.

Security

The sensor must be able to authenticate a person with a sufficiently low FAR rate. Going forward, all signs point toward a need for securely identifying individuals. Currently, the payment industry accepts the use of 0.001–0.002% FAR on sensors in consumer electronics. However, we believe fingerprint application on a stand-alone basis will pull towards the same requirements as law enforcements. i.e. 8–12 minutiae points.

Convenience

The convenience level of a sensor is measured by the false rejection rate (FRR). It measures the probability of rejecting the correct fingerprint. For mass market applicability it should be able to read a fingerprint correctly in over 98–99% of times according to the industry. High FRR will naturally entail frustration and low consumer adoption. To obtain a low FRR, a sensor must be able to read the fingerprint when wet, dry, damaged and cut. It must also be scratch and shock resistant as well as being durable regarding ESD.

Format applicability

Today's mass market applications for fingerprint sensors require sensor formats that will fit their designs, i.e. smartphones, USB tokens, key fobs. The sensors must be sufficiently customisable to meet requirements for colouring, size, flexibility and power consumption.

Cost

High volume markets for fingerprint sensors will not have margins to sustain high prices. According to Microsoft, fingerprint sensors must cost less than USD4 for implementation in all devices.

Competing technologies

We conclude capacitive and thermal sensors are the only viable technology for mass market application today. The ultrasonic principle from Qualcomm looks promising. However, we believe the production cost will be higher than small capacitive and thermal sensors due to the complex nature of the technology currently.

Passive thermal and capacitive swipe sensor: Users of this technology apply different pressure, angle and speed to the swipes. Complex algorithms have so far failed to compensate sufficiently for inconsistent swipes. Hence, these sensors have failed to produce low FRR in a high security environment. Manufacturers of both notebooks and smartphones are moving away from swipe towards touch fingerprint sensors.

Optical sensors: these sensors are big, which makes them unable to fit into today's smaller devices. A company called Vkansee has developed a small optical fingerprint sensor, but we have yet to see it sampling or mass production.

Pressure and traditional ultrasonic sensors have too complex production methods to be commercially viable. However, Qualcomm recently launched a new ultrasonic prototype sensor which could prove to be viable. At this point we do not know performance or price, but we believe it is unlikely that it could compete on cost. That is, unless it is bundled with the chipset from Qualcomm and poses no real addition to the BOM. However, large scale adoption is likely to happen over time (1–3 years).



Appendix

Management

Jörgen Lantto – CEO – stepped up as CEO in May 2015 after being Executive VP CTO since 2013. He is a technical college engineer and has experience as CTO at ST-Ericsson for three years before moving to Fingerprint Cards. He worked 22 years at Ericsson. He took over the position from the previous CEO Johan Carlström who stepped down to focus on business development within the company.

Johan Wilsby – CFO – became CFO of Fingerprint Cards in 2015. He has previous CFO experience from Transmode, HP Nordic region, and for Microsoft region Western Europe since 2004.

Board of directors

Urban Fagerstedt – Chairman – currently works as VP of R&D with Huawei technologies in Sweden and has an MSc in electronics engineering. Over the past five years he has experience from Ericsson's Radio Networks design unit. He is a major shareholder in FPC.

Katarina Bonde – board member since 2015. She currently sits on the board of Propellerhead Software AB, Micro Systemation AB, Image Systems AB, Mycronic AB, Avega Group, Nordax Bank AB and Birger Jarl Fondkommission AB. She has had other directorships in Sweden and the US as. i.e. Chairman of DIBS Payment Services Sverige and Chairman of Netreflector, Inc. She holds no shares.

Alexander Kotsinas – board member – is partner in the venture cap fund Nexttobe AB.

Lars Söderfjell – board member – currently is head of strategy & case research at Ålandsbanken and chairman of the Board of Sunfloro AB. He has long-standing experience of senior executive positions in the fields of equity research and asset management from companies including Myrberg Fondkommission, Danske Bank, Handelsbanken and ABG Sundal Collier. He holds shares in FPC.

Carl-Johan von Plomgren – board member – is currently employed as sales director Northern Europe & chief compliance officer, Villeroy & Boch Gustavsberg. He is board member of Villeroy & Boch Gustavsberg AB, Villeroy & Boch Gustavsberg AS (Norway), Villeroy & Boch Gustavsberg AS (Denmark) and Villeroy & Boch Gustavsberg OY. He has considerable professional experience from senior positions in the IT industry during 1987–2001, gained from such IT companies as Dell, Compaq and WM-data, and subsequently, as of 2001, from industrial and finance companies, such as General Electric, Havells Sylvania and Villeroy & Boch Gustavsberg. He holds shares in FPC.

Jan Wäreby – board member – is currently employed as Senior VP and head of Group Function Sales & Marketing at Ericsson. He is chairman of the Board of LM Ericsson International AB and during 2001–11 was a Board member at Sony Ericsson Mobile Communications AB. He does not hold share in FPC.



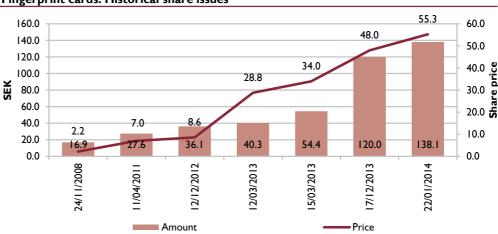
Shareholder structure

Holder Name	Position	% of total Institution Type Country	
AVANZA PENSION FORSAKRING	6.58	11.3% Investment Advisor SWEDEN	
OPPENHEIMER FUNDS INC	4.73	8.1% Investment Advisor UNITED STA	TES
CYBER MEDIC COMPANY LTD	2.33	4.0% n/a n/a	
NORDNET PENSIONSFORSAKRING	1.41	2.4% Pension Fund (ERISA) SWEDEN	
svenska handelsbanken ab	0.91	I.6% Bank SWEDEN	
CBLDN-CIP-IGNIS	0.67	I.I% Other SWEDEN	
skandia liv	0.57	1.0% Pension Fund (ERISA) SWEDEN	
EUROCLEAR BANK SA	0.57	I.0% Bank BELGIUM	
ROBUR FORSAKRING	0.52	0.9% Insurance Company SWEDEN	
FOLKSAM	0.50	0.9% Insurance Company SWEDEN	
HANDELSBANKEN FONDER AB	0.50	0.8% Investment Advisor SWEDEN	
HANSEN TOMMY	0.50	0.8% n/a n/a	
GOLDMAN SACHS & CO	0.47	0.8% Investment Advisor UNITED STA	TES
NETFONDS ASA	0.45	0.8% Investment Advisor NORWAY	
SYDBANK A/S	0.41	0.7% Bank DENMARK	
SPAR NORD BANK A/S	0.39	0.7% n/a n/a	
REX THOMAS	0.37	0.6% n/a n/a	
BLACKROCK FUND ADVISORS	0.21	0.4% Investment Advisor UNITED STA	TES
SWISSCANTO HOLDING AG	0.17	0.3% Investment Advisor SWITZERLA	ND
NUVEEN ASSET MANAGEMENT LLC	0.17	0.3% Investment Advisor UNITED STA	TES
Тор 10	22.43	38.4%	
Other	35.99	61.6%	
Total	58.42	100.0%	

Source: Carnegie Research, Bloomberg

Historical equity issues

FPC cards has issued 58.4m shares in total, 22.5m of which through exercised warrants. In total, it has issued shares for SEK520m, of which 87m through warrants. The company states that it does not need further capital injections.



Fingerprint cards: Historical share issues



Interin	n figure	es											
Fingerprint Cards AB	2014				2015								
SEKm	QI	Q2	Q3	Q4	QI	Q2	Q3e	Q4e	2013	2014	2015e	2016e	2017e
Total revenue	18	44	66	105	I 40	445	859	1,032	95	234	2,476	5,70 I	7,248
Adjusted gross profit	9	21	30	46	51	171	335	422	54	107	978	2,223	2,682
-margin (%)	49%	47%	46%	44%	36%	38%	39%	41%	56%	46%	40%	39%	37%
COGS	-15	-31	-45	-71	-103	-286	-537	-627	-56	-162	-1,553	-3,562	-4,670
Gross profit	4	13	21	34	37	159	322	405	39	72	924	2,138	2,578
-margin (%)	20%	30%	32%	32%	27%	36%	38%	39%	41%	31%	37%	38%	36%
Total Opex	-30	-58	-65	-64	-56	-94	-93	-103	-73	-217	-346	-547	-602
EBITDA	-22	-24	-21	-17	-7	75	239	302	-21	-84	610	1,619	2,009
- margin (%)	neg.	neg.	neg.	neg.	neg.	17%	28%	2 9 %	neg.	neg.	25%	28%	28%
Total D&A	-4	-21	-23	-14	-12	-10	-10	0	-13	-62	-32	-29	-33
EBIT	-27	-45	-44	-30	-19	66	229	302	-34	-145	578	1,591	I, 9 77
Interest income / (expense)	I	0	I	I	0	0	0	0	I	2	0	I	5
PTP	-26	-45	-44	-29	-19	66	229	302	-33	-144	578	1,592	1,982
Tax	0	0	0	-1	0	0	-50	-66	0	0	-117	-62	-436
Net Income	-26	-45	-44	-30	-19	66	179	236	-33	-145	46 I	1,530	1,546
Undiluted EPS	-0.5	-0.8	-0.8	-0.5	-0.3	1.1	3.1	4.0	-0.6	-2.5	7.9	26.2	26.5
Diluted EPS	-0.4	-0.7	-0.7	-0.5	-0.3	1.0	2.8	3.7	-0.6	-2.3	7.3	23.5	23.8
KPI's													
Cash flow from operating activities	-23	-36	-41	-75	21	50	132	196	-29	-174	398	1445	1463
Capital expenditures	14	33	5	39	2	4	4	4	38	91	15	29	36
Order inflow (YTD 2015)	45	60	47	16	295	1254			165	168	1549		
Backlog (SEKm)	41	63	50	71	364	1335			23	71			



Financial statements

Profit & loss	2008	2009	2010	2011	2012	2013	2014	2015e	2016e	2017e
Sales	0	0	0	0	69	95	234	2,476	5,701	7,248
COGS	na	na	na	na	-106	-56	-162	-1,553	-3,562	-4,670
Gross profit	0	0	0	0	-37	39	72	924	2,138	2,578
Other income & costs	0	0	0	0	5	-61	-155	-314	-519	-569
EBITDA	0	0	0	0	-32	-21	-84	610	1,619	2,009
Depreciation PPE	0	0	0	0	-5	-2	-5	-5	-1	-6
Other amortisation	0	0	0	0	0	-11	-27	-27	-27	-27
EBITA	0 0	0 0	0 0	0 0	-37 0	- 34 0	-115 -30	578 0	1,591 0	1,977
GW amortisation & Impairment EO items in EBIT	0	0	0	0	0	0	-30	0	0	0 0
EBIT	0	0	0	0	-37	-34	-145	578	1,591	1,977
Net interest	0	0 0	0	0	0		2	0	1,371	5
Other financial items	0	0 0	0	0	0	0	0	0	0	0
Net financial items	0	0	0	0	0	Í	2	0	Í	5
Share of earnings in ass. comp.	0	0	0	0	0	0	0	0	0	0
EAFI	0	0	0	0	-37	-33	-144	578	1,592	1,982
Other EO items	0	0	0	0	0	0	0	0	0	0
Pre-tax profit	0	0	0	0	-37	-33	-144	578	1,592	1,982
Taxes	na	na	na	na	0	0	0	-117	-62	-436
Post-tax minorities interest	0	0	0	0	0	0	0	0	0	0
Net profit	na	na	na	na	-37	-33	-144	46	1,530	1,546
Adj.Net profit	na	na	na	na	-37	-33	-114	46	1,530	1,546
EO items	0	0	0	0	0	0	0	0	0	0
Tax on EO items	0	0	0	0	0	0	0	0	0	0
Sales growth Y/Y	na	na	na	na	+chg	39.1%	144.9%	960.0%	130.2%	27.2%
EBITA growth Y/Y	na	na	na	na	-chg	+chg	-chg	+chg	175.4%	24.3%
EBITDA margin	nm	nm	nm	nm	-46.8%	-22.5%	-35.7%	24.6%	28.4%	27.7%
EBITA margin Tax rate	nm	nm	nm	nm	nm	nm na	nm -0.3%	23.3% 20.2%	27.9% 3.9%	27.3% 22.0%
	na	na	na	na	na					
Cash flow	2008	2009	2010	2011	2012	2013	2014	2015e	2016e	2017e
EBITDA	0	0	0	0	-32	-21	-84	610	1,619	2,009
Net financial items	0	0	0	0	0	1	2	0	1 0	5
Non cash adjustments	0		0		3 43	-1 -7	-93	-4		0
Change in NWC Paid taxes	na O	na O	na 0	na O	43	-7	-93	-92 -117	-113 -62	-115 -436
Operating cash flow (OCF)	na	na	na	na	15	-29	-174	398	-62 1,445	1,463
CAPEX PPE	0	0	0	0	-10	-36	-74	-10	-20	-25
CAPEX other intang. assets	0	0 0	0	0	-1	-3	-17	-4	-9	-11
Net cash flow (NCF)	na	na	na	na	3	-67	-265	383	1,417	1,427
Other investments/Divestments	0	0	0	0	0	0	0	0	0	0
Dividend paid	0	0	0	0	0	0	0	0	0	0
Share issues & buybacks	0	0	0	0	34	221	155	113	0	0
Other non-cash adjustments	0	0	0	0	0	0	0	0	0	0
Change in LT non-IB liabilities	0	0	0	0	0	0	0	0	0	0
Decrease in net IB debt	na	na	na	na	37	154	-110	496	1,417	1,427
Balance sheet	2008	2000								
Goodwill		2009	2010	2011	2012	2013	2014	2015e	2016e	2017e
	0	0	0	0	0	0	0	0	0	0
Other fixed intangible assets	0 0	0 0	0 0	0 0	0 28	0 54	0 70	0 52	0 45	0 43
Other fixed intangible assets PPE	0 0 0	0 0 0	0 0 0	0 0 0	0 28 4	0 54 5	0 70 19	0 52 20	0 45 27	0 43 32
Other fixed intangible assets PPE Shares & participations	0 0 0 na	0 0 0 na	0 0 0 na	0 0 0 na	0 28 4 0	0 54 5 0	0 70 19 0	0 52 20 0	0 45 27 0	0 43 32 0
Other fixed intangible assets PPE Shares & participations Other fixed financial assets	0 0 na 0	0 0 na 0	0 0 na 0	0 0 na 0	0 28 4 0 I	0 54 5 0 0	0 70 19 0 0	0 52 20 0	0 45 27 0 0	0 43 32 0 0
Other fixed intangible assets PPE Shares & participations Other fixed financial assets Other fixed assets	0 0 na 0 0	0 0 na 0 0	0 0 na 0 0	0 0 na 0 0	0 28 4 0 1 0	0 54 5 0 0	0 70 19 0 0	0 52 20 0 0	0 45 27 0 0	0 43 32 0 0 0
Other fixed intangible assets PPE Shares & participations Other fixed financial assets Other fixed assets Fixed assets	0 0 na 0 0 na	0 0 na 0 0 na	0 0 na 0 0 na	0 0 na 0 0 na	0 28 4 0 I 0 33	0 54 5 0 0 0 60	0 70 19 0 0 88	0 52 20 0 0 0 71	0 45 27 0 0 0 7 1	0 43 32 0 0 0 75
Other fixed intangible assets PPE Shares & participations Other fixed financial assets Other fixed assets Fixed assets Inventories	0 0 na 0 0 na na	0 0 na 0 0 na na	0 0 na 0 0 na na	0 0 na 0 na na	0 28 4 0 1 0 33 4	0 54 5 0 0 0 60 20	0 70 19 0 0 0 88 99	0 52 20 0 0 0 71 251	0 45 27 0 0 0 7 1 356	0 43 32 0 0 0 75 467
Other fixed intangible assets PPE Shares & participations Other fixed financial assets Other fixed assets Fixed assets Inventories Receivables	0 0 na 0 0 na na	0 0 na 0 0 na na	0 0 na 0 0 na na na	0 0 na 0 0 na na	0 28 4 0 1 0 33 4 53	0 54 5 0 0 0 60 20 31	0 70 19 0 0 0 88 99 116	0 52 20 0 0 0 7 1 25 1 495	0 45 27 0 0 0 7 1 356 941	0 43 32 0 0 0 75 467 1,015
Other fixed intangible assets PPE Shares & participations Other fixed financial assets Other fixed assets Fixed assets Inventories Receivables Other current assets	0 0 na 0 0 na na	0 0 na 0 0 na na	0 0 na 0 0 na na	0 0 na 0 na na	0 28 4 0 1 0 33 4	0 54 5 0 0 0 60 20	0 70 19 0 0 0 88 99	0 52 20 0 0 0 71 251	0 45 27 0 0 0 7 1 356	0 43 32 0 0 0 0 75 467
Other fixed intangible assets PPE Shares & participations Other fixed financial assets Other fixed assets Fixed assets Inventories Receivables	0 0 na 0 na na na 0	0 0 na 0 na na 0	0 0 na 0 na na na 0	0 0 na 0 na na na 0	0 28 4 0 1 0 33 4 53 3	0 54 5 0 0 0 60 20 31 8	0 70 19 0 0 0 88 99 116 20	0 52 20 0 0 0 7 1 25 1 495 47	0 45 27 0 0 0 7 1 356 941 101	0 43 32 0 0 0 75 467 1,015 127
Other fixed intangible assets PPE Shares & participations Other fixed financial assets Other fixed assets Fixed assets Inventories Receivables Other current assets Cash & cash equivalents	0 0 na 0 na na 0 na	0 0 na 0 na na 0 na	0 0 na 0 na na na 0 na	0 0 na 0 na na 0 na	0 28 4 0 1 0 33 4 53 3 23	0 54 5 0 0 0 60 20 31 8 212	0 70 19 0 0 0 88 99 116 20 102	0 52 20 0 0 7 1 251 495 47 533	0 45 27 0 0 0 71 356 941 101 1,949	0 43 32 0 0 0 75 467 1,015 127 3,376
Other fixed intangible assets PPE Shares & participations Other fixed financial assets Other fixed assets Fixed assets Fixed assets Inventories Receivables Other current assets Cash & cash equivalents Current assets Total assets	0 0 na 0 na na 0 na na na	0 0 na 0 na na 0 na na na	0 0 na 0 na na na 0 na na na	0 0 na 0 na na 0 na na na	0 28 4 0 1 0 33 4 53 3 23 84 117	0 54 5 0 0 0 60 20 31 8 212 271 330	0 70 19 0 0 88 99 116 20 102 336 425	0 52 20 0 0 71 251 495 47 533 1,326 1,397	0 45 27 0 0 71 356 941 101 1,949 3,347 3,418	0 43 32 0 0 75 467 1,015 127 3,376 4,985 5,059
Other fixed intangible assets PPE Shares & participations Other fixed financial assets Other fixed assets Fixed assets Fixed assets Inventories Receivables Other current assets Cash & cash equivalents Current assets Total assets Shareholders' equity	0 0 na 0 na na 0 na na na na na	0 0 na 0 na na 0 na na na na	0 0 na 0 na na 0 na na na na	0 0 na 0 na na 0 na na na na	0 28 4 0 1 0 33 4 53 3 23 84 117 0	0 54 5 0 0 0 0 60 20 31 8 212 271 330 288	0 70 19 0 0 88 99 116 20 102 336 425 301	0 52 20 0 0 71 251 495 47 533 1,326 1,397 809	0 45 27 0 0 71 356 941 101 1,949 3,347 3,418 2,339	0 43 32 0 0 75 467 1,015 127 3,376 4,985
Other fixed intangible assets PPE Shares & participations Other fixed financial assets Other fixed assets Fixed assets Fixed assets Inventories Receivables Other current assets Cash & cash equivalents Current assets Total assets	0 0 na 0 na na 0 na na na	0 0 na 0 na na 0 na na na	0 0 na 0 na na na 0 na na na	0 0 na 0 na na 0 na na na	0 28 4 0 1 0 33 4 53 3 23 84 117	0 54 5 0 0 0 60 20 31 8 212 271 330	0 70 19 0 0 88 99 116 20 102 336 425	0 52 20 0 0 71 251 495 47 533 1,326 1,397	0 45 27 0 0 71 356 941 101 1,949 3,347 3,418	0 43 32 0 0 75 467 1,015 127 3,376 4,985 5,059 3,885
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Share data & key ratios

Per share data (SEK)	2008	2009	2010	2011	2012	2013	2014	2015e	2016e	2017e
Adj. no. of shares in issue YE (m)	0.00	0.00	0.00	0.00	47.81	54.16	58.42	58.42	58.42	58.42
Diluted no. of Shares YE (m)	0.00	0.00	0.00	0.00	44.22	56.66	62.94	63.24	65.04	65.04
EPS	na	na	na	na	-0.84	-0.65	-2.41	7.3	23.9	23.8
EPS adj.	na	na	na	na	-0.84	-0.65	-1.91	7.3	23.9	23.8
CEPS	na	na	na	na	-0.73	-0.40	-1.38	7.8	24.3	24.3
DPS BVPS	0.00	0.00	0.00	0.00	0.00	0.00	0.00	0.00	0.00 40.0	0.00
BVPS ex. GW	na	na	na	na	0.00 0.00	5.3 5.3	5.2 5.2	13.8 13.8	40.0	66.5 66.5
NAVPS	na na	na na	na na	na na	0.00	5.3	5.2	13.8	40.0	66.5
NIBDPS	na	na	na	na	-0.54	-3.74	-1.62	-8.42	-29.97	-51.90
Valuation	2008	2009	2010	2011	2012	2013	2014	2015e	2016e	2017e
P/E YE	na	na	na	na	nm	nm	nm	29.1	8.9	9.0
P/E adj. YE	na	na	na	na	nm	nm	nm	29.1	8.9	9.0
P/E average	na	na	na	na	neg.	neg.	neg.	29.1	8.9	9.0
P/E adj. average	na	na	na	na	neg.	neg.	neg.	29.1	8.9	9.0
P/CEPS YE	na	na	na	na	neg.	neg.	neg.	27.2	8.8	8.8
P/BV YE	na	na	na	na	nm	10.22	6.75	15.38	5.32	3.20
P/BV ex. GW YE	na	na	na 0.0%	na 0.0%	nm 0.0%	10.22 0.0%	6.75 0.0%	15.38 0.0%	5.32 0.0%	3.20 0.0%
Dividend yield YE Dividend Payout Ratio	na na	na na	0.0% na	0.0% na	0.0%	0.0%	0.0%	0.0%	0.0%	0.0%
EV/EBIT YE										
EV/EBITA YE	na na	na na	na na	na na	neg.	neg.	neg.	22.4 22.4	7.5 7.5	5.3 5.3
EV/EBITA adj. YE	na	na na	na	na	neg. neg.	neg. neg.	neg. neg.	22.4	7.5 7.5	5.3
EV/Sales YE	na	na	na	na	7.6	30.0	8.9	5.2	2.1	1.4
EV/EBITDA YE	na	na	na	na	neg.	neg.	neg.	21.2	7.4	5.2
Share price YE			8.95	9.30	12.4	54.3	34.8	213		
Share price high			10.2	9.60	14.1	84.5	64.3	273		
Share price low			6.30	4.86	2.66	12.9	27.9	28.8		
Share price average			8.63	7.16	6.46	43.9	46.9	103		
Margins	2008	2009	2010	2011	2012	2013	2014	2015e	2016e	2017e
Gross margin	na	na	na	na	-53.9%	41.0%	30.7%	37.3%	37.5%	35.6%
EBITDA margin	nm	nm	nm	nm	-46.8%	-22.5%	-35.7%	24.6%	28.4%	27.7%
Adj. EBITDA margin	nm	nm	nm	nm	-46.8%	-22.5%	-35.7%	24.6%	28.4%	27.7%
EBITA margin	nm	nm	nm	nm	nm	nm	nm 40.2%	23.3%	27.9%	27.3%
Adj. EBITA margin Pre-tax margin	nm nm	nm nm	nm nm	nm nm	-53.9% -53.9%	-35.7% -34.5%	-49.3% -61.5%	23.3% 23.3%	27.9% 27.9%	27.3% 27.3%
Net margin	na	na	na	na	-53.9%	-34.5%	-61.7%	18.6%	26.8%	21.3%
Adj. net margin	na	na	na	na	-53.9%	-34.5%	-48.8%	18.6%	26.8%	21.3%
Profitability	2008	2009	2010	2011	2012	2013	2014	2015e	2016e	2017e
ROE	na	na	na	na	na	-22.9%	-48.9%	83.1%	97.2%	49.7%
Adj. ROE	na	na	na	na	na	-22.9%	-38.7%	83.1%	97.2%	49.7%
Adj. ROCE pre-tax	na	na	na	na	na	-22.9%	-38.6%	104.1%	101.2%	63.7%
Adj. ROIC aft-tax	na	na	na	na	na	-39.0%	-71.8%	166.7%	385.3%	280.3%
Adj. ROA pre-tax	na	na	na	na	na	-14.7%	-30.1%	63.5%	66.1%	46.8%
FCF yield	na	na	na	na	0.0%	-0.5%	-2.0%	2.8%	10.5%	10.6%
Capital eff./Solv.	2008	2009	2010	2011	2012	2013	2014	2015e	2016e	2017e
Inventories / Sales	1.0%	1.0%	1.0%	1.0%	1.0%	1.0%	1.0%	1.0%	1.0%	1.0%
Receivables / Sales	1.0%	1.0%	1.0%	1.0%	1.0%	1.0%	1.0%	1.0%	1.0%	1.0%
Payables / Sales	1.0%	1.0%	1.0%	1.0%	1.0%	1.0%	1.0%	1.0%	1.0%	1.0%
NWC / Sales	na	na	na	na	na	43.3%	37.2%	7.9%	5.7%	6.6%
Asset turnover Sales / Capital invested	na	na	na	na	na	0.43 1.09	0.62 1.45	2.72 8.96	2.37 14.37	1.71 13.17
OCF / Capex	na na	na na	na na	na na	na 1.39	-0.80	-2.37	38.26	72.43	57.67
Capex / Sales	nm	nm	nm	nm	1.57	37.5%	31.5%	0.4%	0.4%	0.4%
Capex / Depreciation PPE	nm	nm	nm	nm	2.12	17.89	15.79	2.04	14.05	4.58
Dividend payout ratio	na	na	na	na	0%	0%	0%	0%	0%	0%
Equity / Total assets	na	na	na	na	0%	87%	71%	58%	68%	77%
Net IB debt / Equity	na	na	na	na	nm	-74%	-34%	-66%	-83%	-87%
Net IB debt / EBITDA	na	na	na	na	0.7	9.9	1.2	-0.9	-1.2	-1.7
EBITDA / Net interest	nm	nm	nm	nm	nm	19.7	50.0	n.m.	n.m.	n.m.
EBITA / Net interest	nm	nm	nm	nm	nm	31.2	69.0	n.m.	n.m.	n.m.
Balance sheet data	2008	2009	2010	2011	2012	2013	2014	2015e	2016e	2017e
Net IB debt	na	na	na	na	-24	-212	-102	-533	-1,949	-3,376
Net working capital (NWC)	na	na	na	na	57	25	149	245	406	548
Capital employed (CE)	na	na	na	na	0 90	288	301	809	2,339	3,885
Capital invested (CI) Enterprise value YE (EV)	na na	na na	na na	na na	90 522	85 2,862	237 2,089	316 12,937	478 11,904	623 10,477
	IIa	114	114	114	JLL	2,002	2,007	12,737	T1,707	10,777



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Current rating system as of October 2011 Buy(B), an upside of at least 10% to target price and with an attractive risk/reward profile

Hold(H), the share is trading close to its target price and is fairly valued

Sell(S), unattractive risk/reward-ratio as the share is trading above its target price

Not rated(NR), Under review(UR), Under bid(UB). The investment rating, if any, has been suspended temporarily.

Risk assessment

The risk assessment is based on the analyst's evaluation of the company's equity beta based on the business risk (asset beta) and financial risk (gearing).

Low risk Estimated equity beta <0.75 Medium risk Estimated equity beta 0.75 to 1.25 High risk Estimated equity beta >1.25

Share Price

The share price is as of 07 Sep 2015 17:16

Target price

Analyst valuation methods

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Fingerprint Cards price, rating and target price history (FINGb.ST)

Source: Carnegie Research, Factset

Rating structure prior to October 2011

Carnegie stock rating relative on a Nordic sector basis. Each stock was rated on the basis of how it was expected to perform against its sector on a 6month investment horizon. Outperform (OP), Neutral (N), Underperform (U): the stock was expected to outperform, perform in line with, underperform, respectively, the return on the Carnegie coverage universe of the Nordic Sector over the next six months.

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The following disclosures relate to relationships between Carnegie Investment Bank AB (with its subsidiaries, "Carnegie") and the subject company.

Within the past 12 months Carnegie (refer to definition in disclaimer text) has received compensation for investment banking services from Akastor, Aker Solutions, Asetek, Bang & Olufsen, DSV, ICA Gruppen, Medivir, NEL, NRC Group, Oasmia Pharmaceutical, Recipharm, Spar Nord Bank, Weifa and Vistin Pharma ASA.

Within the past 12 months Carnegie (refer to definition in disclaimer text) has managed or co-managed a public offering of securities of Alimak, Capio AB, Dustin, Evolution Gaming, Hoist Finance, Inwido, Lifco, Nobina, Nordax, Nordic Nanovector, Pandox, RenoNorden, Scatec Solar, Tobii, Troax and XXL.

Please see Carnegie's website for a full list of shares owned by employees of Carnegie AS in relation to potential conflicts of interest: www.carnegie.no, Verdipapirhandel, Analyse, Disclaimer (Norwegian). www.carnegie.no, Securities, Research, Disclaimer (English). Carnegie AS may also own shares in connection with trading. This disclosure is made to meet Norwegian best practice.

Since April 30, 2013 Carnegie AS acts as a market maker in the EAM Solar share.

Since September 30, 2010 Carnegie Investment Bank AB acts as a market maker in the Fagerhult share.

Since September 30, 2010 Carnegie Investment Bank AB acts as a market maker in the FastPartner share.

Since September 30, 2010 Carnegie Investment Bank AB acts as a market maker in the Unibet share.

Since May 2, 2013 Carnegie Investment Bank AB acts as a market maker in the Formpipe Software share.

Since October 23, 2014 Carnegie Investment Bank AB acts as a market maker in the Oscar Properties share.

Stock rating distribution in the previous 12 months

Ratings	Carnegie coverage universe % of total	Investment banking services* % of total	
Buy	48	70	
Hold	41	23	
Sell	П	7	

*Investment banking services provided by Carnegie in the previous 12 months

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Fingerprint Cards Company Summary

Profit & loss	2013	2014	2015e	2016e	2017e
Sales	95	234	2,476	5,701	7,248
EBITDA	-21	-84	610	1,619	2,009
EBITA	-34	-115	578	1,591	1,977
EBIT	-34	-145	578	1,591	1,977
Pre-tax profit	-33	-144	578	1,592	1,982
Net profit	-33	-144	461	1,530	1,546
EO items	0	0	0	0	0
Balance sheet	2013	2014	2015e	2016e	2017e
Total assets	330	425	1,397	3,418	5,059
Shareholders' equity	288	301	809	2,339	3,885
Goodwill	0	0	0	0	0
Net IB debt	-212	-102	-533	-1,949	-3,376
Cash flow	2013	2014	2015e	2016e	2017e
EBITDA	-21	-84	610	1,619	2,009
Operating cash flow	-29	-174	398	1,445	1,463
Net cash flow (NCF)	-67	-265	383	1,417	1,427
Decrease in net IB debt	154	-110	496	1,417	1,427

Per share data	2013	2014	2015e	2016e	2017e
EPS	-0.65	-2.41	7.3	23.9	23.8
EPS adj.	-0.65	-1.91	7.3	23.9	23.8
EPS adj. Growth	+chg	-chg	+chg	226.4%	-0.4%
CEPS	-0.40	-1.38	7.8	24.3	24.3
DPS	0.00	0.00	0.00	0.00	0.00
BVPS ex. GW	5.3	5.2	13.8	40.0	66.5
NIBDPS	-3.74	-1.62	-8.42	-29.97	-51.90
Ratios	2013	2014	2015e	2016e	2017e
P/E	nm	nm	29.1	8.9	9.0
P/E adj.	nm	nm	29.1	8.9	9.0
P/BVPS	40.I	41.3	15.4	5.3	3.2
P/BVPS ex. GW	40.I	41.3	15.4	5.3	3.2
P/CEPS	neg.	neg.	27.2	8.8	8.8
EV/Sales	>50	>50	5.2	2.0	1.4
EV/EBITDA	neg.	neg.	21.2	7.1	5.0
EV/EBITA	neg.	neg.	22.4	7.2	5.I
Dividend yield	0.0%	0.0%	0.0%	0.0%	0.0%
FCF yield	-0.5%	-2.0%	2.8%	10.5%	10.6%

Sales by business area

Asia	95.4%
Americas	3.4%
EMEA	1.2%
Sweden	0.1%

Company description

Fingerprint Cards AB is a Sweden-based technology company, which develops, produces and markets biometric technology, which, through analysis and matching of an individual's unique fingerprint, verifies the person's identity. The technology consists of biometric sensors, processors, algorithms and modules that can be used separately or combined.

Source: Carnegie Research
Kungsportsplatsen 2
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www.fingerprints.com

Major shareholders

	Capital	Votes		Capital	Votes
AVANZA PENSIOI	11.3%	11.3%	NORDNET PENSI	2.4%	2.4%
OPPENHEIMER FU	8.1%	8.1%	SVENSKA HANDE	1.6%	1.6%
CYBER MEDIC CC	4.0%	4.0%	CBLDN-CIP-IGNIS	1.1%	1.1%

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